

# REF50xx Low-Noise, Very Low Drift, Wide $V_{IN}$ Precision Voltage Reference

## 1 Features

- Low temperature drift (maximum):
  - Enhanced-grade (new): 2.5ppm/°C
  - High-grade: 3ppm/°C
  - Standard-grade: 8ppm/°C
- High accuracy (maximum):
  - Enhanced-grade: 0.025%
  - High-grade: 0.05%
  - Standard-grade: 0.1%
- Low noise:
  - Enhanced-grade:  $0.5\mu V_{PP}/V$
  - High/standard-grade:  $3\mu V_{PP}/V$
- Excellent long-term stability:
  - 22ppm after first 1000 hours (SOIC-8)
  - 50ppm after first 1000 hours (VSSOP-8)
- Wide input voltage support:
  - Enhanced-grade: 42V
  - High/standard-grade: 18V
- High-output current:  $\pm 10\text{mA}$
- Temperature range:  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$

## 2 Applications

- Precision data acquisition systems
- Semiconductor test equipment
- Industrial process controls
- Medical instrumentation
- Pressure and temperature transmitters
- Lab and field instrumentation

## 3 Description

The REF50xx is a family of low-noise, low-drift, very high precision voltage references. The references are capable of both sinking and sourcing current, and have excellent line and load regulation.

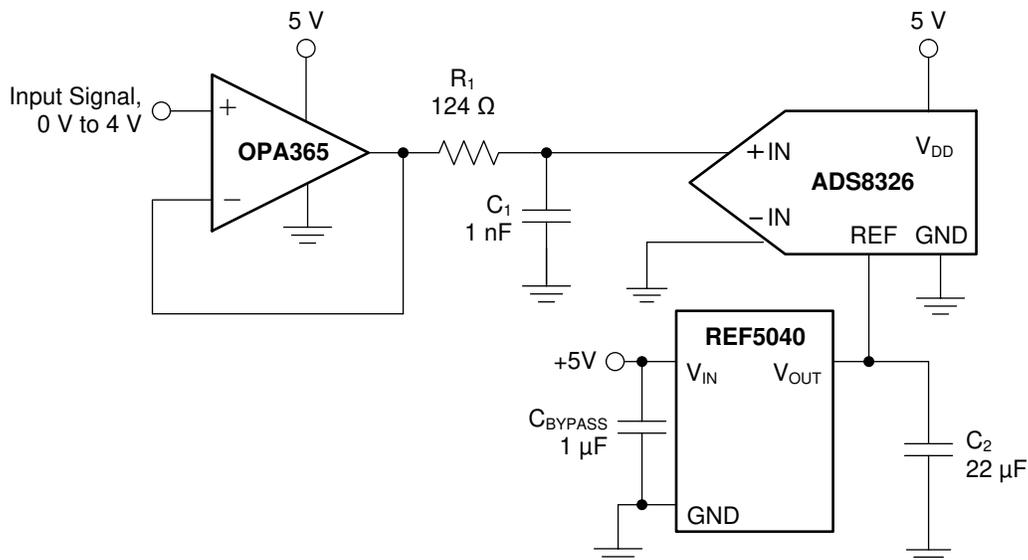
Achieve excellent temperature drift (2.5ppm/°C) and high accuracy (0.025%) using proprietary design techniques. These features, combined with very low flicker noise ( $0.5\mu V_{PP}/V$ ), make the REF50xx family an excellent choice for use in high-precision data acquisition systems. REF50 family is available in enhanced grade (REF50xxEI), high grade (REF50xxI), and standard grade (REF50xxAI). The reference voltages are offered in 8-pin SOIC and VSSOP packages and are specified from  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ .

For detailed comparison across various grades, refer to [Table 4-2](#).

### Package Information

| PART NUMBER | PACKAGE <sup>(1)</sup> | PACKAGE SIZE <sup>(2)</sup> |
|-------------|------------------------|-----------------------------|
| REF50xxI    | D (SOIC, 8)            | 4.90mm × 3.91mm             |
| REF50xxAI   | DGK (VSSOP, 8)         | 3.00mm × 3.00mm             |
| REF50xxEI   | D (SOIC, 8)            | 4.90mm × 3.91mm             |

- (1) For all available packages, see the orderable addendum at the end of the data sheet.
- (2) The package size (length × width) is a nominal value and includes pins, where applicable.



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Simplified Schematic



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## 4 Device Comparison Table

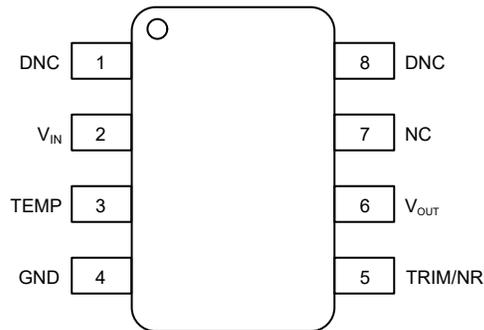
**Table 4-1. Device V<sub>OUT</sub> Comparison**

| PRODUCT    |           |            |             |              | Voltage |
|------------|-----------|------------|-------------|--------------|---------|
| SOIC (8)   |           | VSSOP (8)  |             |              |         |
| N/A        | REF5020ID | REF5020AID | REF5020IDGK | REF5020AIDGK | 2.048V  |
| REF5025EID | REF5025ID | REF5025AID | REF5025IDGK | REF5025AIDGK | 2.5V    |
| REF5030EID | REF5030ID | REF5030AID | REF5030IDGK | REF5030AIDGK | 3V      |
| REF5040EID | REF5040ID | REF5040AID | REF5040IDGK | REF5040AIDGK | 4.096V  |
| REF5045EID | REF5045ID | REF5045AID | REF5045IDGK | REF5045AIDGK | 4.5V    |
| REF5050EID | REF5050ID | REF5050AID | REF5050IDGK | REF5050AIDGK | 5.0V    |
| N/A        | REF5010ID | REF5010AID | REF5010IDGK | REF5010AIDGK | 10.0V   |

**Table 4-2. Device Performance Comparison**

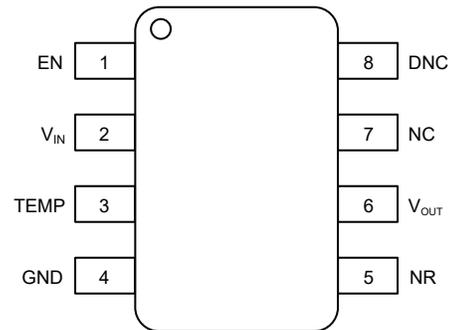
| Device    | Grade    | Temperature Coefficient | Initial Accuracy | Noise                  | V <sub>IN</sub> Max | Quiescent Current Max |
|-----------|----------|-------------------------|------------------|------------------------|---------------------|-----------------------|
| REF50xxEI | Enhanced | 2.5ppm/°C               | ±0.025%          | 0.5μV <sub>pp</sub> /V | 42V                 | 480μA                 |
| REF50xxI  | High     | 3ppm/°C                 | ±0.05%           | 3μV <sub>pp</sub> /V   | 18V                 | 1.2mA                 |
| REF50xxAI | Standard | 8ppm/°C                 | ±0.1%            | 3μV <sub>pp</sub> /V   | 18V                 | 1.2mA                 |

## 5 Pin Configuration and Functions



Not to scale

**Figure 5-1. REF50xxAI, REF50xxI  
8-Pin SOIC, VSSOP  
Top View**



Not to scale

**Figure 5-2. REF50xxEI  
8-Pin SOIC  
Top View**

**Table 5-1. Pin Functions**

| NAME             | PIN                 |           | DESCRIPTION   |
|------------------|---------------------|-----------|---|
|                  | REF50xxI, REF50xxAI | REF50xxEI |   |
| DNC              | 1, 8                | 8         | Do not connect  |
| EN               | -                   | 1         | Device enable control. Low level input disables the reference output and device enters shutdown mode. Device can be enabled by driving voltage > 1.6V or leaving the EN pin floating. |
| GND              | 4                   | 4         | Ground  |
| NC               | 7                   |           | No internal connection  |
| NC               |                     | 7         | Leave floating or connect to GND  |
| NR               | -                   | 5         | Noise reduction pin   |
| TEMP             | 3                   | 3         | Temperature monitoring pin. Provides a temperature-dependent output voltage   |
| TRIM/NR          | 5                   | -         | Output adjustment or noise reduction pin  |
| V <sub>IN</sub>  | 2                   | 2         | Input supply voltage  |
| V <sub>OUT</sub> | 6                   | 6         | Reference voltage output  |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                           |                         | MIN  | MAX | UNIT |
|---------------------------|-------------------------|------|-----|------|
| Input voltage             | $V_{IN}$ <sup>(2)</sup> | -0.3 | 18  | V    |
|                           | $V_{IN}$ <sup>(3)</sup> | -0.3 | 48  |      |
| Output Voltage            | $V_{OUT}$               | -0.3 | 5.5 | V    |
| Operating temperature     | ( $T_A$ )               | -55  | 125 | °C   |
| Junction temperature      | ( $T_J$ max)            |      | 150 |      |
| Storage temperature range | ( $T_{stg}$ )           | -65  | 150 |      |

- (1) Operation outside the *Absolute Maximum Ratings* may cause permanent device damage. *Absolute Maximum Ratings* do not imply functional operation of the device at these or any other conditions beyond those listed under *Recommended Operating Conditions*. If used outside the *Recommended Operating Conditions* but within the *Absolute Maximum Ratings*, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.
- (2) Specification for REF5xxI and REF50xxAI.
- (3) Specification for REF50xxEI.

### 6.2 ESD Ratings

|             |  |  | VALUE  | UNIT |
|-------------|--|--|--------|------|
| $V_{(ESD)}$ | Electrostatic discharge <sup>(3)</sup> | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>              | ± 3000 | V    |
|             |  | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> | ± 1000 |      |
|             | Electrostatic discharge <sup>(4)</sup> | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>              | ± 2000 |      |
|             |  | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> | ± 500  |      |

- (1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.
- (3) Specification for REF50xxI and REF50xxAI.
- (4) Specification for REF50xxEI.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|           |                                | MIN                            | NOM | MAX | UNIT |
|-----------|--------------------------------|--------------------------------|-----|-----|------|
| $V_{IN}$  | Input voltage <sup>(2)</sup>   | $V_{OUT} + 0.2$ <sup>(1)</sup> |     | 18  | V    |
|           | Input voltage <sup>(3)</sup>   | $V_{OUT} + 0.2$                |     | 42  | V    |
| NR        | Noise reduction <sup>(3)</sup> | 0                              |     | 6   | V    |
| $I_{OUT}$ | Output current                 | -10                            |     | 10  | mA   |
| $T_A$     | Operating ambient temperature  | -40                            | 25  | 125 | °C   |

- (1) Except for the REF5020, where  $V_{IN}$  (minimum) = 2.7V.
- (2) Specification for REF50xxI and REF50xxAI.
- (3) Specification for REF50xxEI.

## 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |  | REF50xxEI | REF50xxI , REF50xxAI |             | UNIT |
|-------------------------------|--|-----------|----------------------|-------------|------|
|                               |  | D (SOIC)  | D (SOIC)             | DGK (VSSOP) |      |
|                               |  | 8 PINS    | 8 PINS               | 8 PINS      |      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 120       | 115                  | 160.9       | °C/W |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 52        | 63.4                 | 53.9        | °C/W |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 66        | 57.1                 | 82.9        | °C/W |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter   | 9.8       | 15.4                 | 5.1         | °C/W |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter | 64.7      | 56.2                 | 80.7        | °C/W |
| $R_{\theta JC(bot)}$          | Junction-to-case (bottom) thermal resistance | N/A       | N/A                  | N/A         | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics application note](#).

## 6.5 Electrical Characteristics REF50xxI and REF50xxAI

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ ,  $C_L = 1\mu\text{F}$  and  $V_{\text{IN}} = (V_{\text{OUT}} + 0.2\text{V})$  to 18V, unless otherwise noted

| PARAMETER                               |                       | TEST CONDITION  | MIN   | TYP   | MAX  | UNIT                                |
|---|-----------------------|---|-------|-------|------|-------------------------------------|
| <b>OUTPUT VOLTAGE</b>                   |                       |   |       |       |      |                                     |
| $V_{\text{OUT}}$                        | Output Voltage        | REF5020 ( $V_{\text{OUT}} = 2.048\text{V}$ ) <sup>(1)</sup> , $2.7\text{V} < V_{\text{IN}} < 18\text{V}$  |       | 2.048 |      | V                                   |
|   |                       | REF5025   |       | 2.5   |      |                                     |
|   |                       | REF5030   |       | 3.0   |      |                                     |
|   |                       | REF5040   |       | 4.096 |      |                                     |
|   |                       | REF5045   |       | 4.5   |      |                                     |
|   |                       | REF5050   |       | 5     |      |                                     |
|   |                       | REF5010   |       | 10    |      |                                     |
| Initial Accuracy                        | High Grade            | All voltage options <sup>(1)</sup>  | -0.05 |       | 0.05 | %                                   |
|   | Standard Grade        | All voltage options <sup>(1)</sup>  | -0.1  |       | 0.1  | %                                   |
| <b>NOISE</b>                            |                       |   |       |       |      |                                     |
| $e_{\text{Npp}}$                        | Low Frequency noise   | $f = 0.1\text{Hz to } 10\text{Hz}$  |       | 3     |      | $\mu\text{V}_{\text{pp}}/\text{V}$  |
| $e_{\text{n}}$                          | Output Voltage Noise  | $f = 10\text{Hz to } 1\text{kHz}$   |       | 0.9   |      | $\mu\text{V}_{\text{rms}}/\text{V}$ |
| <b>OUTPUT VOLTAGE TEMPERATURE DRIFT</b> |                       |   |       |       |      |                                     |
| $dV_{\text{OUT}}/dT$                    | High grade            | $T_A = -40^\circ\text{C to } 125^\circ\text{C}$   |       | 2.5   | 3    | pm/ $^\circ\text{C}$                |
|   | Standard grade        |   |       | 3     | 8    |                                     |
| <b>LINE REGULATION</b>                  |                       |   |       |       |      |                                     |
| $\Delta V_{\text{O}(\Delta\text{VI})}$  | Line regulation       | $V_{\text{IN}} = (V_{\text{OUT}} + 0.2\text{V})$ to $18\text{V}$ <sup>(1)</sup>   |       | 1     | 3    | ppm/V                               |
|   |                       | $V_{\text{IN}} = (V_{\text{OUT}} + 0.2\text{V})$ TO $18\text{V}$ , $T_A = -40^\circ\text{C to } 125^\circ\text{C}$ <sup>(1)</sup>                               |       | 1     | 5    |                                     |
| <b>LOAD REGULATION</b>                  |                       |   |       |       |      |                                     |
| $\Delta V_{\text{O}(\Delta\text{IL})}$  | Load regulation       | $-10\text{mA} < I_{\text{OUT}} < 10\text{mA}$ , $V_{\text{IN}} = V_{\text{OUT}} + 0.75\text{V}$ <sup>(2)</sup>  |       | 20    | 30   | ppm/mA                              |
|   |                       | $10\text{mA} < I_{\text{OUT}} < 10\text{mA}$ , $V_{\text{IN}} = V_{\text{OUT}} + 0.75\text{V}$ <sup>(2)</sup> , $T_A = -40^\circ\text{C to } 125^\circ\text{C}$ |       |       |      |                                     |
| <b>SHORT-CIRCUIT CURRENT</b>            |                       |   |       |       |      |                                     |
| $I_{\text{SC}}$                         | Short circuit current | $V_{\text{OUT}} = 0$  |       | 25    |      | mA                                  |
| <b>THERMAL HYSTERESIS</b>               |                       |   |       |       |      |                                     |
| High grade                              | VSSOP-8               | Cycle 1   |       | 50    |      | ppm                                 |
|   |                       | Cycle 2   |       | 40    |      |                                     |
|   | SOIC-8                | Cycle 1   |       | 70    |      |                                     |
|   |                       | Cycle 2   |       | 50    |      |                                     |
| Standard grade                          | VSSOP-8               | Cycle 1   |       | 70    |      |                                     |
|   |                       | Cycle 2   |       | 40    |      |                                     |
|   | SOIC-8                | Cycle 1   |       | 90    |      |                                     |
|   |                       | Cycle 2   |       | 50    |      |                                     |
| <b>LONG-TERM STABILITY</b>              |                       |   |       |       |      |                                     |
| $\Delta V_{\text{OUT\_LTD}}$            | VSSOP-8               | 0 to 1000 hours   |       | 50    |      | ppm                                 |
|   |                       | 1000 to 2000 hours  |       | 25    |      |                                     |
|   | SOIC-8                | 0 to 1000 hours   |       | 22    |      |                                     |
|   |                       | 1000 to 2000 hours  |       | 18    |      |                                     |
| <b>TEMP PIN</b>                         |                       |   |       |       |      |                                     |
| Voltage output                          |                       |   |       | 575   |      | mV                                  |
| Temperature sensitivity                 |                       | $T_A = -40^\circ\text{C to } 125^\circ\text{C}$   |       | 2.64  |      | mV/ $^\circ\text{C}$                |

## 6.5 Electrical Characteristics REF50xxI and REF50xxAI (continued)

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ ,  $C_L = 1\mu\text{F}$  and  $V_{\text{IN}} = (V_{\text{OUT}} + 0.2\text{V})$  to 18V, unless otherwise noted

| PARAMETER                    |                | TEST CONDITION                                      | MIN                    | TYP | MAX | UNIT             |
|------------------------------|----------------|---|------------------------|-----|-----|------------------|
| <b>TURN-ON SETTLING TIME</b> |                |   |                        |     |     |                  |
| Turn-on settling time        |                | To 0.1% with $C_L = 1\mu\text{F}$                   |                        | 200 |     | $\mu\text{s}$    |
| <b>POWER SUPPLY</b>          |                |   |                        |     |     |                  |
| $V_S$                        | Supply voltage | See note (1)  | $V_{\text{OUT}} + 0.2$ |     | 18  | V                |
| Quiescent current            |                |   |                        | 0.8 | 1   | mA               |
|                              |                | $-40^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$ |                        |     | 1.2 |                  |
| <b>TEMPERATURE RANGE</b>     |                |   |                        |     |     |                  |
| Specified range              |                |   | -40                    |     | 125 | $^\circ\text{C}$ |
| Operating range              |                |   | -55                    |     | 125 | $^\circ\text{C}$ |

(1) For  $V_{\text{OUT}} \leq 2.5\text{V}$ , the minimum supply voltage is 2.7V.

(2) Except for REF5020, where  $V_{\text{IN}} = 3\text{V}$ .

## 6.6 Electrical Characteristics REF50xxEI

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ ,  $C_L = 1\mu\text{F}$  and  $V_{\text{IN}} = V_{\text{EN}} = (V_{\text{OUT}} + 0.25\text{V})$ , unless otherwise noted

| PARAMETER   |                               | TEST CONDITION  | MIN                    | TYP   | MAX   | UNIT                                |
|---|-------------------------------|---|------------------------|-------|-------|-------------------------------------|
| <b>OUTPUT VOLTAGE</b>                             |                               |   |                        |       |       |                                     |
| $V_{\text{OUT}}$                                  | Output Voltage                | REF5025E  |                        | 2.5   |       | V                                   |
|   |                               | REF5030E  |                        | 3.0   |       | V                                   |
|   |                               | REF5040E  |                        | 4.096 |       | V                                   |
|   |                               | REF5045E  |                        | 4.5   |       | V                                   |
|   |                               | REF5050E  |                        | 5     |       | V                                   |
| $I_A$   | Initial accuracy              | All voltage options   | -0.025                 |       | 0.025 | %                                   |
| $dV_{\text{OUT}}/dT$                              |                               | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$  |                        |       | 2.5   | ppm/ $^\circ\text{C}$               |
| <b>NOISE</b>                                      |                               |   |                        |       |       |                                     |
| $e_{\text{npp}}$                                  | Low Frequency noise           | $f = 0.1\text{Hz}$ to $10\text{Hz}$   |                        | 0.5   |       | $\mu\text{V}_{\text{pp}}/\text{V}$  |
| $e_n$   | Output Voltage Noise          | $f = 10\text{Hz}$ to $1\text{kHz}$  |                        | 0.8   |       | $\mu\text{V}_{\text{rms}}/\text{V}$ |
| <b>LINE REGULATION</b>                            |                               |   |                        |       |       |                                     |
| $\Delta V_{\text{O}(\Delta\text{VI})}$            | Line regulation               | $V_{\text{IN}} = (V_{\text{OUT}} + 0.2\text{V})$ to $42\text{V}$  |                        | 1     | 3     | ppm/V                               |
|   |                               | $V_{\text{IN}} = V_{\text{OUT}} + 0.2\text{V}$ to $42\text{V}$ , $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$                                 |                        | 1     | 5     |                                     |
| <b>LOAD REGULATION</b>                            |                               |   |                        |       |       |                                     |
| $\Delta V_{\text{O}(\Delta\text{IL})}$            | Load regulation               | $-10\text{mA} < I_{\text{OUT}} < 10\text{mA}$ , $V_{\text{IN}} = V_{\text{OUT}} + 0.75\text{V}$   |                        | 5     | 25    | ppm/mA                              |
|   |                               | $10\text{mA} < I_{\text{OUT}} < 10\text{mA}$ , $V_{\text{IN}} = V_{\text{OUT}} + 0.75\text{V}$ , $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |                        |       | 35    |                                     |
| <b>SHORT-CIRCUIT CURRENT</b>                      |                               |   |                        |       |       |                                     |
| $I_{\text{SC}}$                                   | Short circuit current         | $V_{\text{OUT}} = 0$  |                        | 21    |       | mA                                  |
| <b>THERMAL HYSTERESIS AND LONG-TERM STABILITY</b> |                               |   |                        |       |       |                                     |
| TH  | SOIC-8                        | Cycle 1   |                        | 80    |       | ppm                                 |
|   | SOIC-8                        | Cycle 2   |                        | 20    |       | ppm                                 |
| <b>LONG-TERM STABILITY</b>                        |                               |   |                        |       |       |                                     |
| $\Delta V_{\text{OUT\_LTD}}$                      | SOIC-8                        | 0 to 1000 hours   |                        | 25    |       | ppm                                 |
|   |                               | 1000 to 2000 hours  |                        | 10    |       | ppm                                 |
| <b>TEMP PIN</b>                                   |                               |   |                        |       |       |                                     |
| Voltage output                                    |                               |   |                        | 625   |       | mV                                  |
| Temperature sensitivity                           |                               | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$  |                        | 2.64  |       | mV/ $^\circ\text{C}$                |
| <b>TURN-ON SETTLING TIME</b>                      |                               |   |                        |       |       |                                     |
| Turn-on settling time                             |                               | To 0.1% with $C_L = 1\mu\text{F}$   |                        | 400   |       | $\mu\text{s}$                       |
| <b>CAPACITIVE LOAD</b>                            |                               |   |                        |       |       |                                     |
| $C_{\text{IN}}$                                   | Stable input capacitor range  | $-40^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$   |                        | 0.1   |       | $\mu\text{F}$                       |
| $C_L$   | Stable output capacitor range | $-40^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$   |                        | 1     | 100   | $\mu\text{F}$                       |
| <b>POWER SUPPLY</b>                               |                               |   |                        |       |       |                                     |
| $V_S$   | Supply voltage                | See note  | $V_{\text{OUT}} + 0.2$ |       | 42    | V                                   |
| Quiescent current                                 |                               |   |                        | 340   |       | $\mu\text{A}$                       |
|   |                               | $-40^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$   |                        |       | 480   | $\mu\text{A}$                       |
| Quiescent current                                 | Shunt down current            | $V_{\text{EN}} = 0\text{V}$   |                        | 10    |       | $\mu\text{A}$                       |
| Enable Voltage                                    | $V_{\text{EN}}$               | Active mode (EN = 1)  |                        | 1.6   |       | V                                   |
|   |                               | Shutdown Mode (EN = 0)  |                        |       | 0.5   | V                                   |
| <b>TEMPERATURE RANGE</b>                          |                               |   |                        |       |       |                                     |

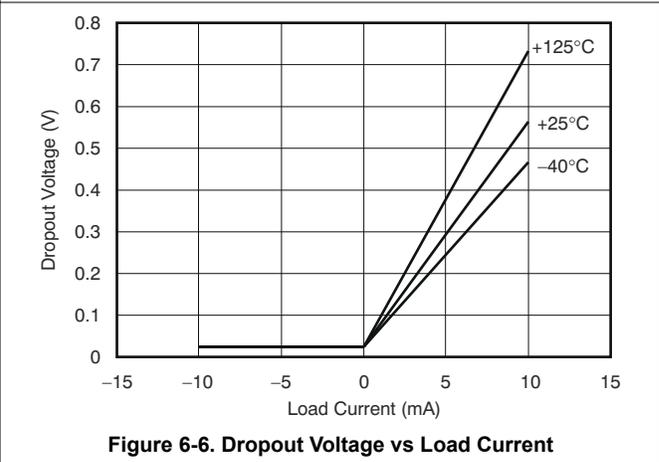
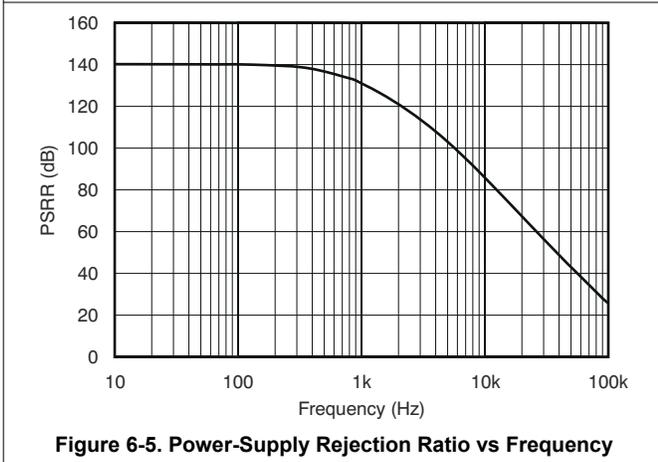
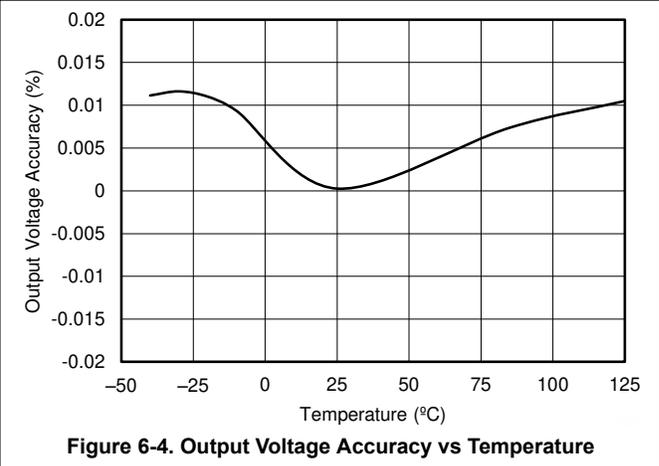
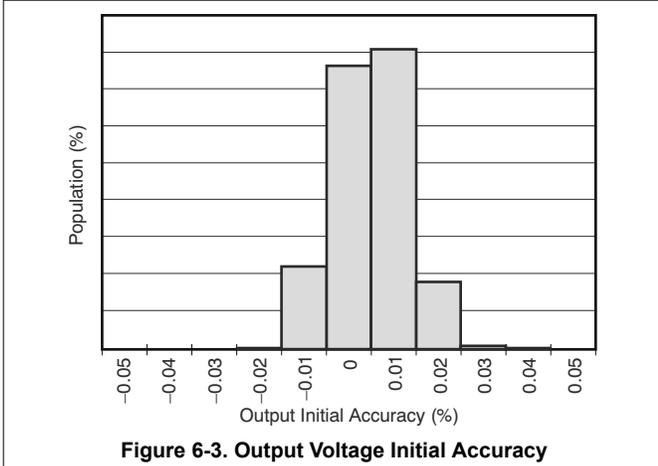
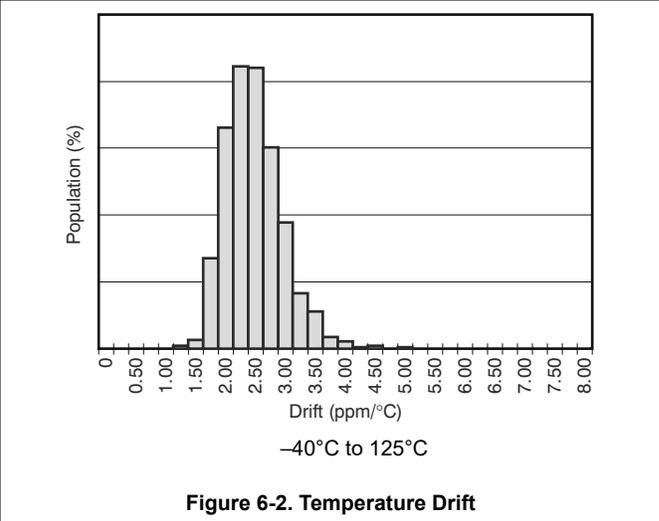
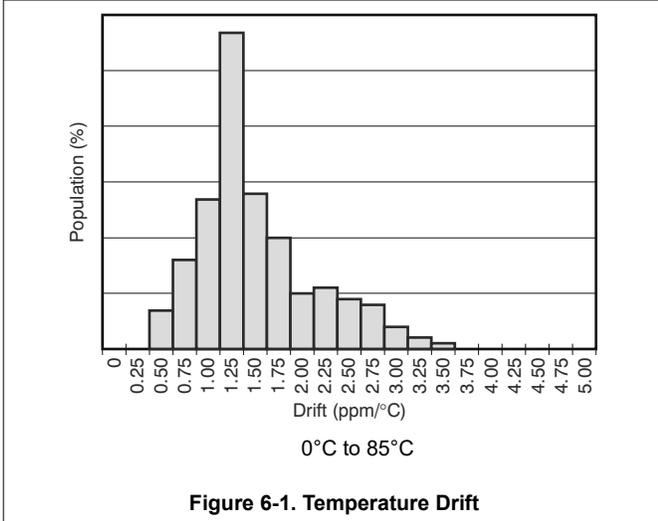
## 6.6 Electrical Characteristics REF50xxEI (continued)

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ ,  $C_L = 1\mu\text{F}$  and  $V_{\text{IN}} = V_{\text{EN}} = (V_{\text{OUT}} + 0.25\text{V})$ , unless otherwise noted

| PARAMETER       | TEST CONDITION | MIN | TYP | MAX | UNIT             |
|-----------------|----------------|-----|-----|-----|------------------|
| Specified range |                | -40 |     | 125 | $^\circ\text{C}$ |

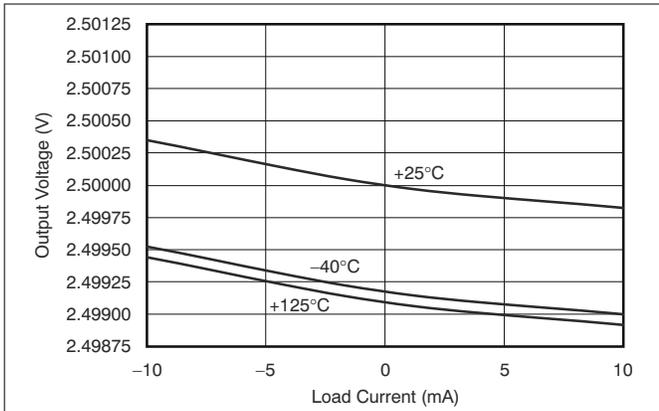
### 6.7 Typical Characteristics: REF50xxI, REF50xxAI

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ , and  $V_S = V_{\text{OUT}} + 0.2\text{V}$ , unless otherwise noted. For  $V_{\text{OUT}} \leq 2.5\text{V}$ , the minimum supply voltage is 2.7 V.

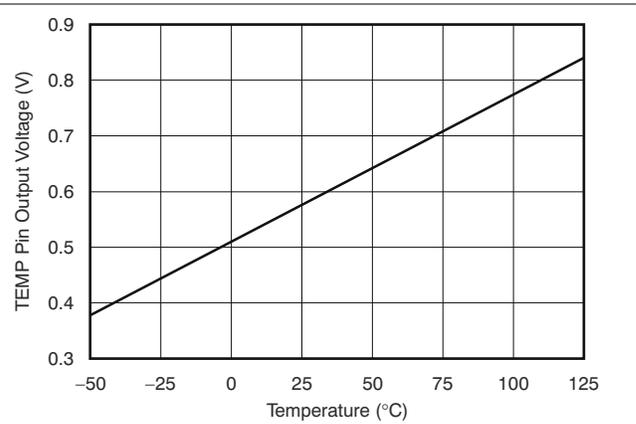


### 6.7 Typical Characteristics: REF50xxI, REF50xxAI (continued)

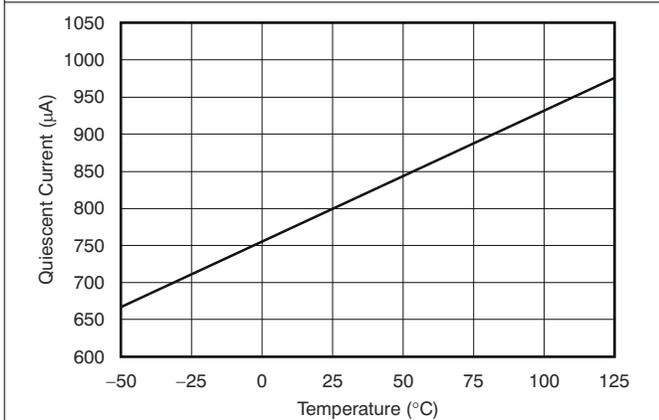
At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ , and  $V_S = V_{\text{OUT}} + 0.2\text{V}$ , unless otherwise noted. For  $V_{\text{OUT}} \leq 2.5\text{V}$ , the minimum supply voltage is 2.7 V.



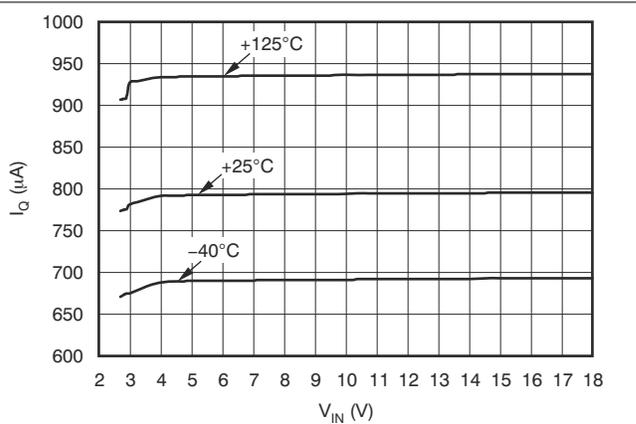
**Figure 6-7. REF5025 Output Voltage vs Load Current**



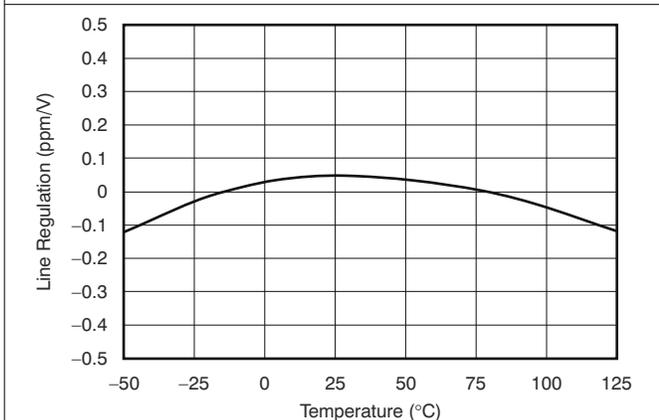
**Figure 6-8. Temp Pin Output Voltage vs Temperature**



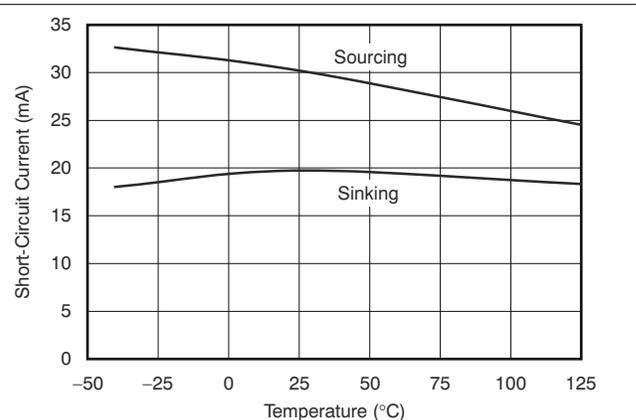
**Figure 6-9. Quiescent Current vs Temperature**



**Figure 6-10. Quiescent Current vs Input Voltage**



**Figure 6-11. Line Regulation vs Temperature**



**Figure 6-12. Short Circuit Current vs Temperature**

### 6.7 Typical Characteristics: REF50xxI, REF50xxAI (continued)

At  $T_A = 25^\circ\text{C}$ ,  $I_{LOAD} = 0$ , and  $V_S = V_{OUT} + 0.2\text{V}$ , unless otherwise noted. For  $V_{OUT} \leq 2.5\text{V}$ , the minimum supply voltage is 2.7 V.

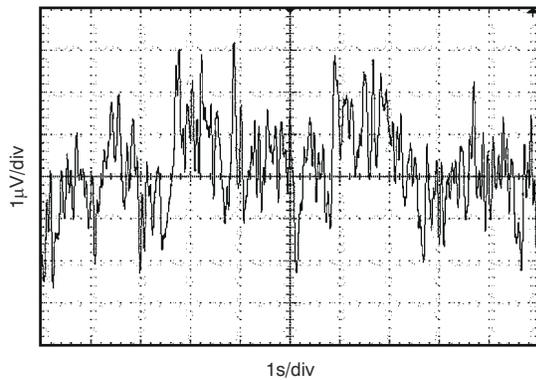


Figure 6-13. 0.1Hz to 10Hz Noise

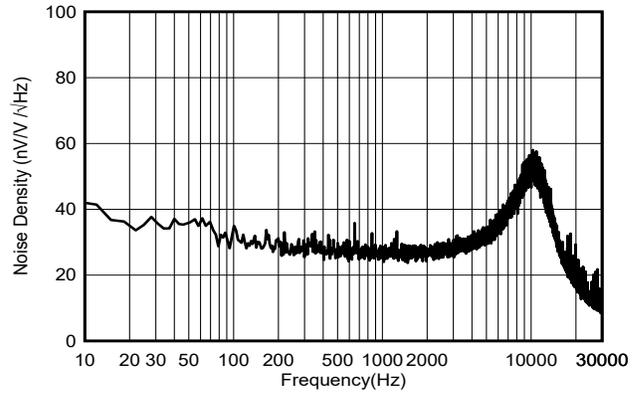
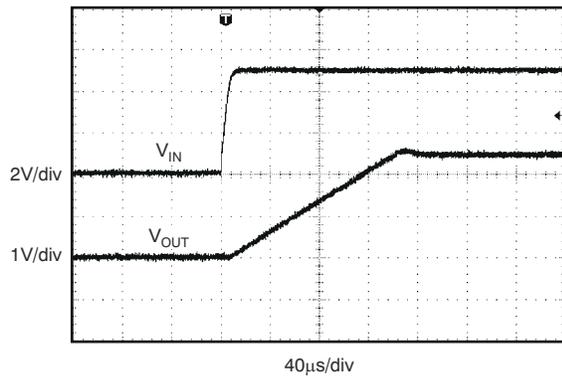
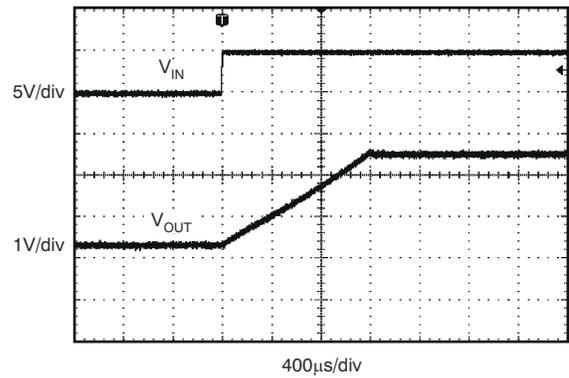


Figure 6-14. Noise Spectral Density



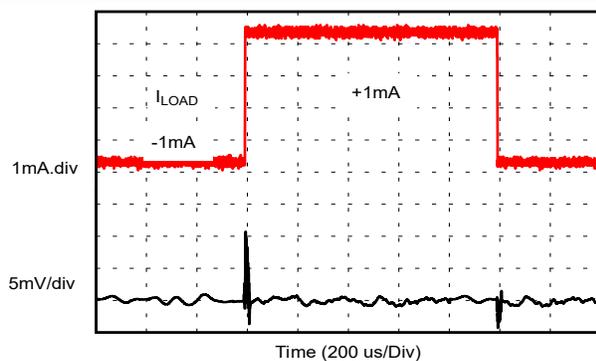
REF5025,  $C_L = 1\mu\text{F}$

Figure 6-15. Start-Up



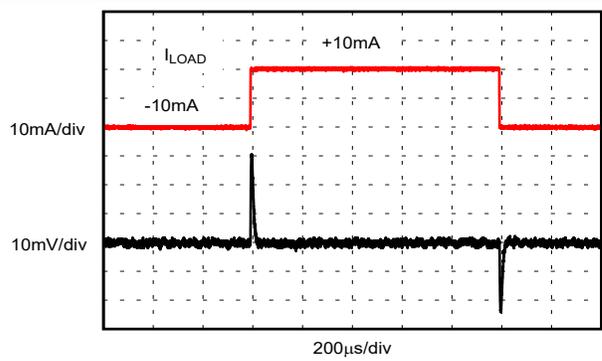
REF5025,  $C_L = 10\mu\text{F}$

Figure 6-16. Start-Up



$C_L = 1\mu\text{F}$ ,  $I_{OUT} = 1\text{mA}$

Figure 6-17. Load Transient

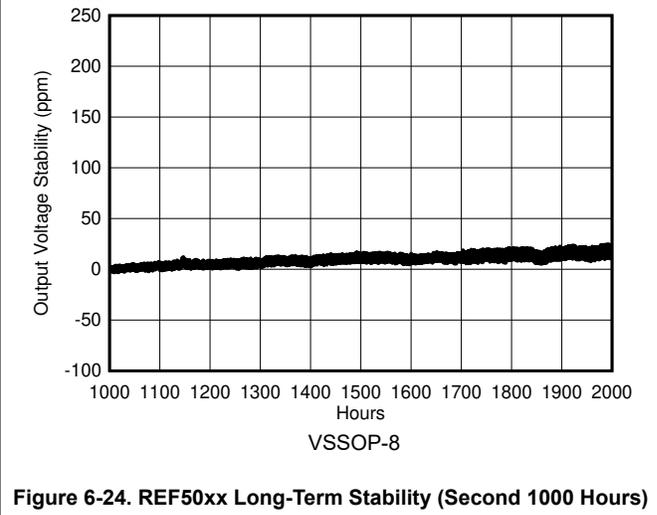
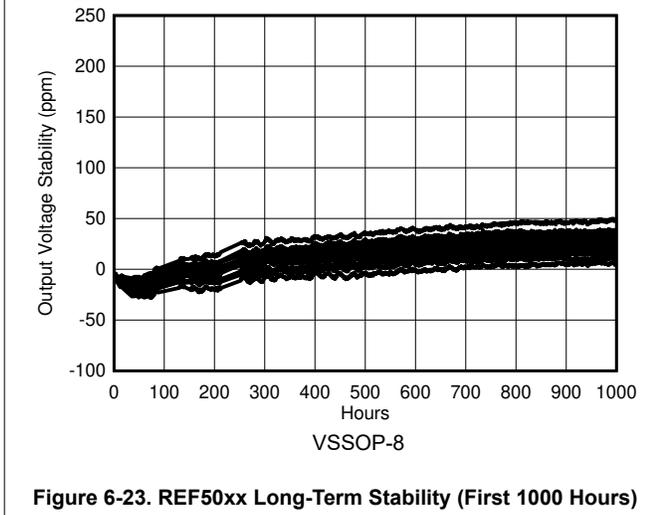
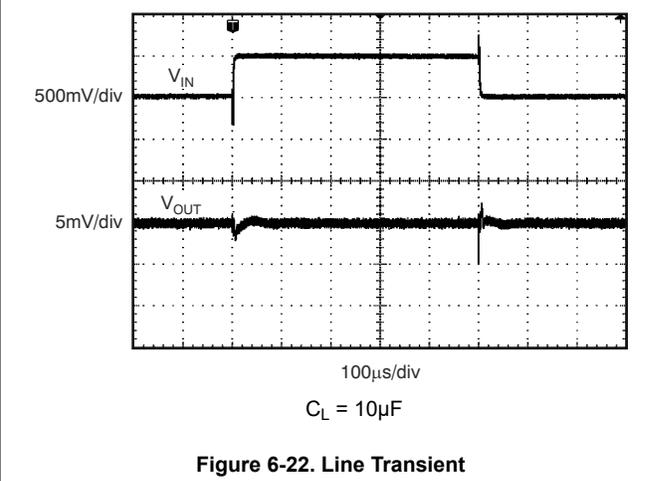
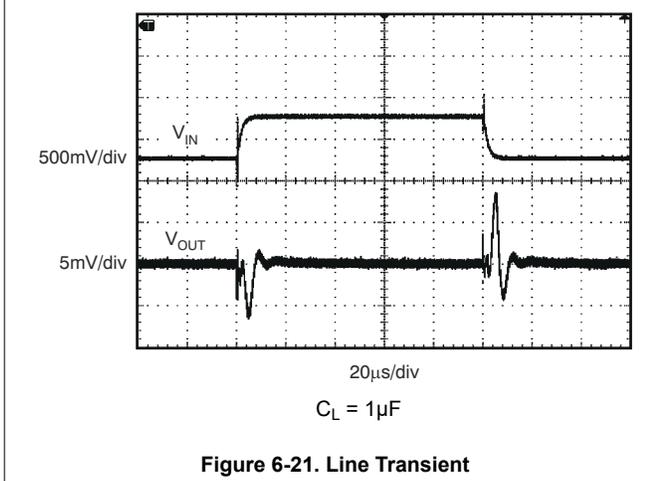
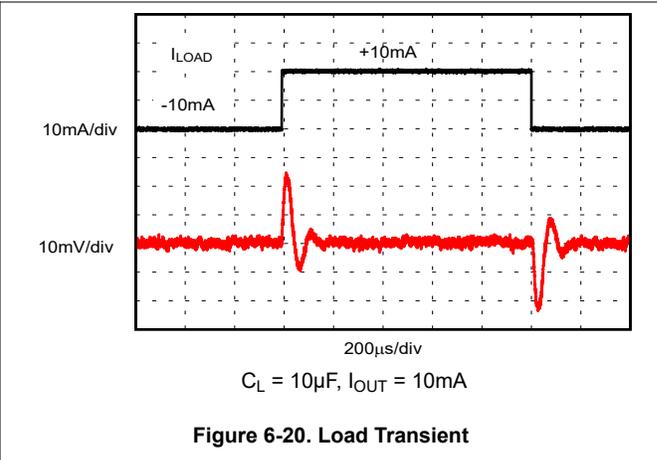
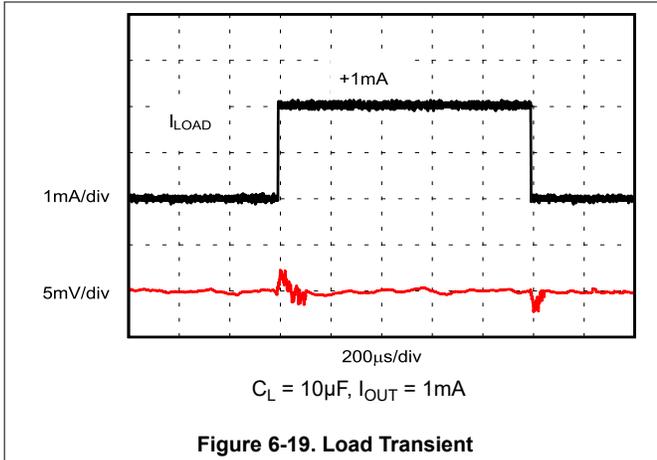


$C_L = 1\mu\text{F}$ ,  $I_{OUT} = 10\text{mA}$

Figure 6-18. Load Transient

### 6.7 Typical Characteristics: REF50xxI, REF50xxAI (continued)

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ , and  $V_S = V_{\text{OUT}} + 0.2\text{V}$ , unless otherwise noted. For  $V_{\text{OUT}} \leq 2.5\text{V}$ , the minimum supply voltage is 2.7 V.



### 6.7 Typical Characteristics: REF50xxI, REF50xxAI (continued)

At  $T_A = 25^\circ\text{C}$ ,  $I_{\text{LOAD}} = 0$ , and  $V_S = V_{\text{OUT}} + 0.2\text{V}$ , unless otherwise noted. For  $V_{\text{OUT}} \leq 2.5\text{V}$ , the minimum supply voltage is 2.7 V.

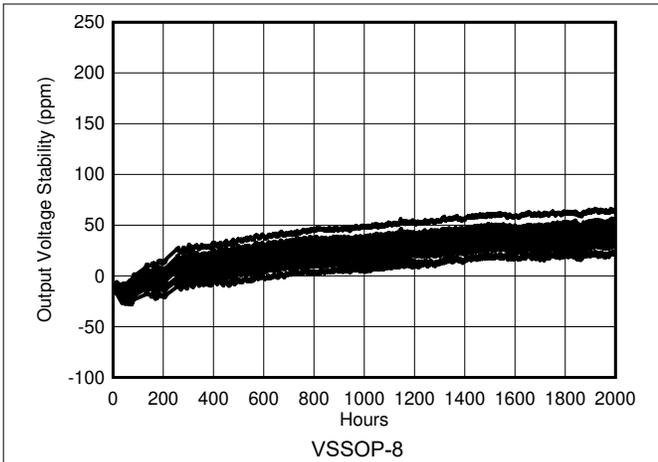


Figure 6-25. REF50xx Long-Term Stability (First 2000 Hours)

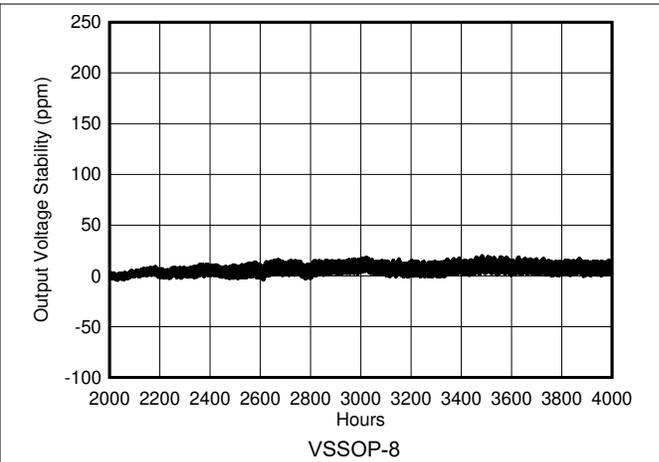


Figure 6-26. REF50xx Long-Term Stability (Second 2000 Hours)

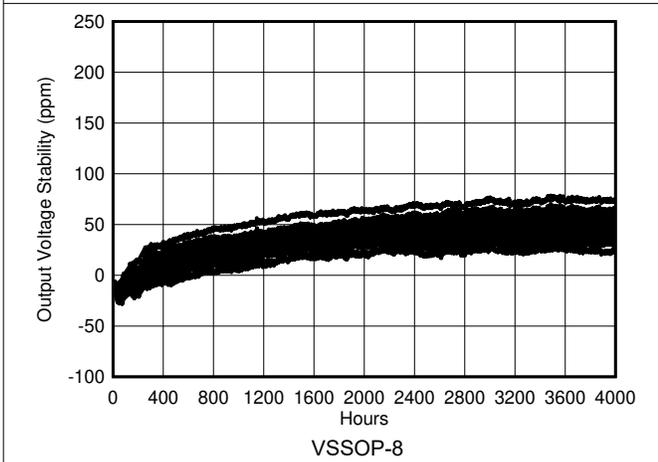


Figure 6-27. REF50xx Long-Term Stability (4000 Hours)

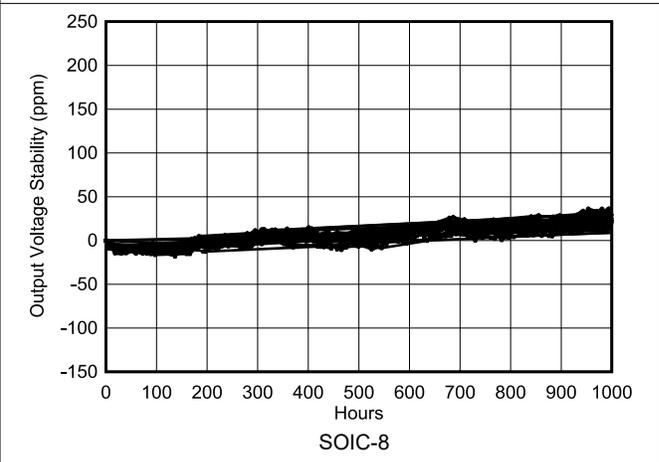


Figure 6-28. REF50xx Long-Term Stability (First 1000 Hours)

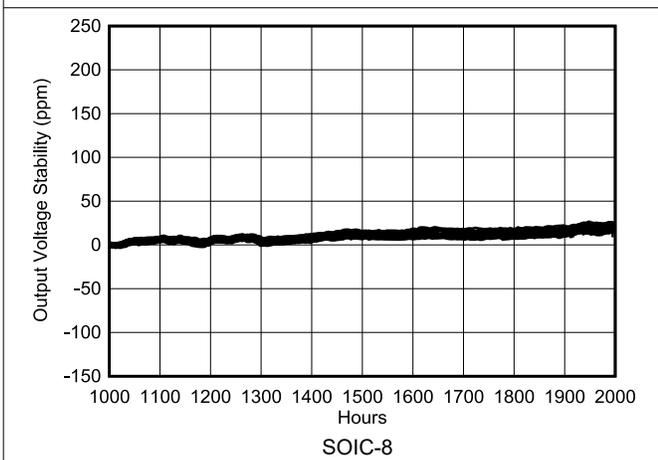


Figure 6-29. REF50xx Long-Term Stability (Second 1000 Hours)

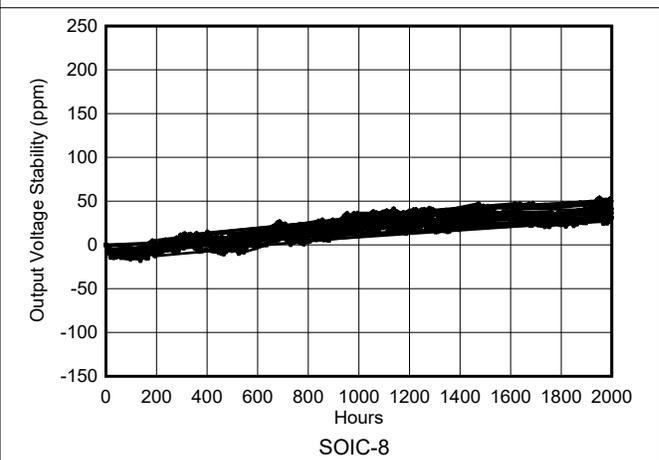


Figure 6-30. REF50xx Long-Term Stability (2000 Hours)

### 6.8 Typical Characteristics: REF50xxEI

at  $T_A = 25^\circ\text{C}$ ,  $V_{IN} = V_{EN} = V_{OUT} + 0.5\text{V}$ ,  $I_L = 0\text{mA}$ ,  $C_{Out} = 10\mu\text{F}$ ,  $C_{NR} = \text{Open}$ ,  $C_{IN} = 0.1\mu\text{F}$ ,

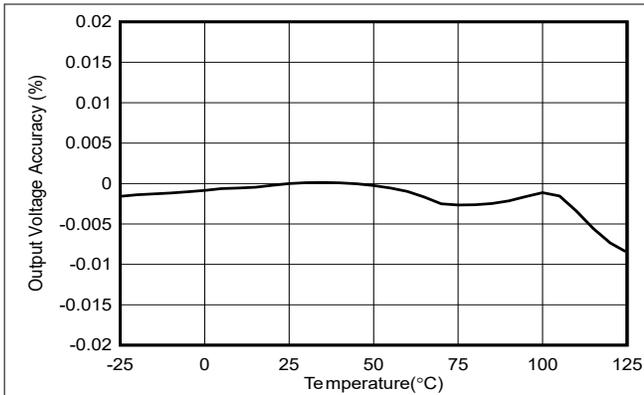


Figure 6-31. Output Voltage Vs Free-Air Temperature

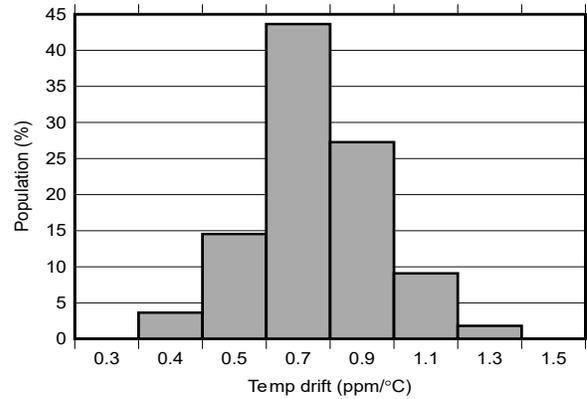


Figure 6-32. Temperature Drift Distribution

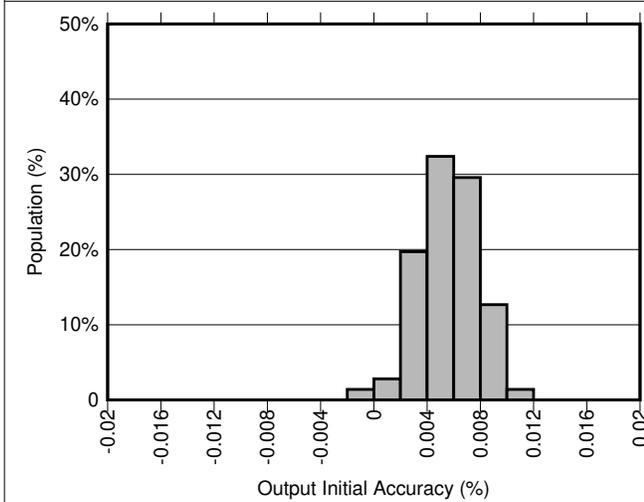


Figure 6-33. Accuracy Distribution

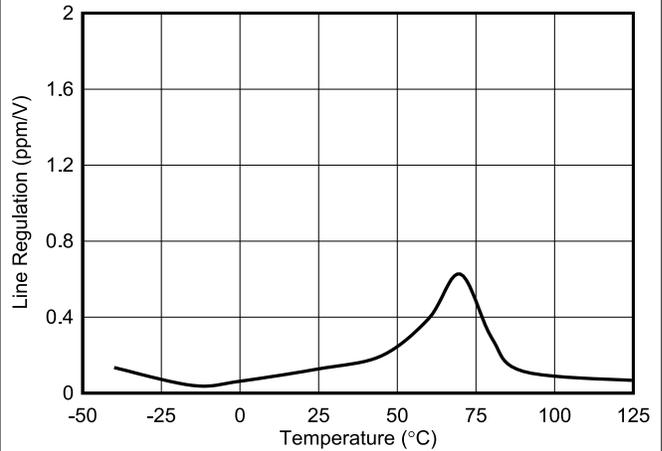


Figure 6-34. Line Regulation vs Temperature

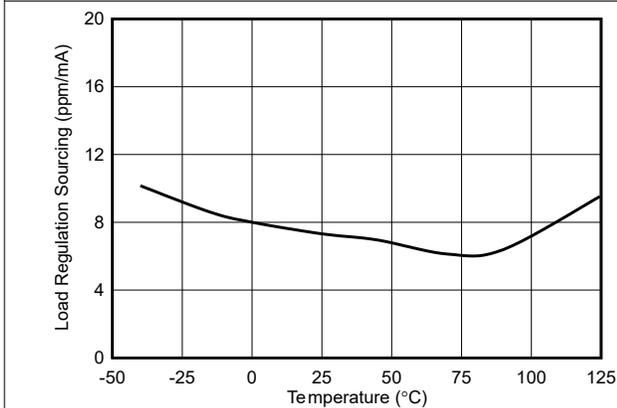


Figure 6-35. Load Regulation (Sourcing) vs Temperature

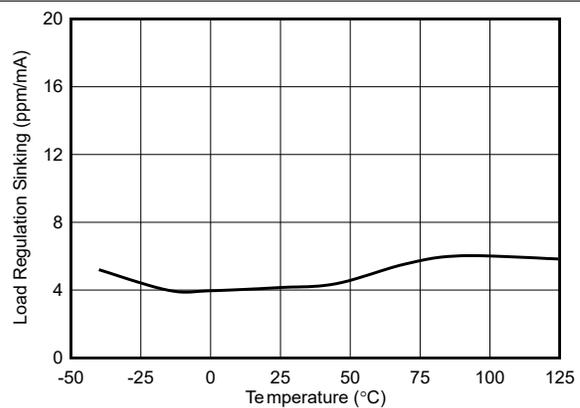


Figure 6-36. Load Regulation (Sinking) vs Temperature

### 6.8 Typical Characteristics: REF50xxEI (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_{IN} = V_{EN} = V_{OUT} + 0.5\text{V}$ ,  $I_L = 0\text{mA}$ ,  $C_{OUT} = 10\mu\text{F}$ ,  $C_{NR} = \text{Open}$ ,  $C_{IN} = 0.1\mu\text{F}$ ,

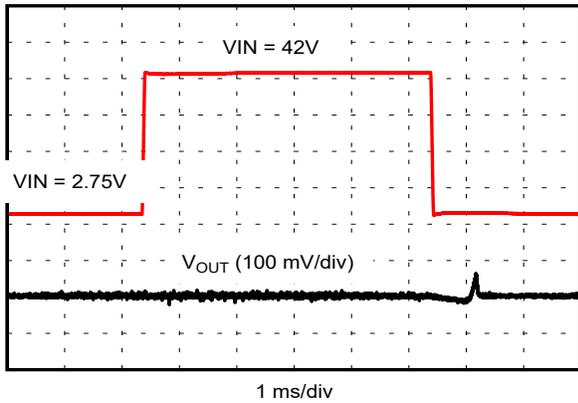


Figure 6-37. Line Transient Response

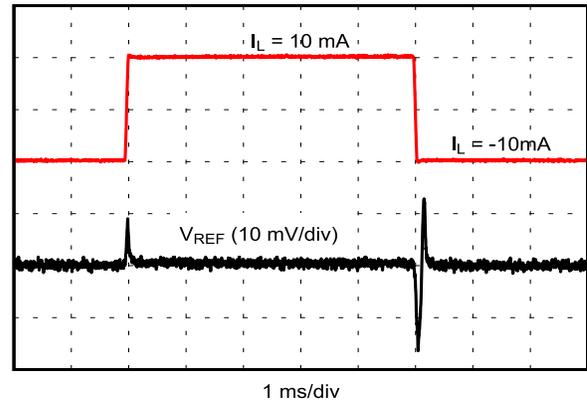


Figure 6-38. Load Transient Response ( $C_{OUT} = 10\mu\text{F}$ )

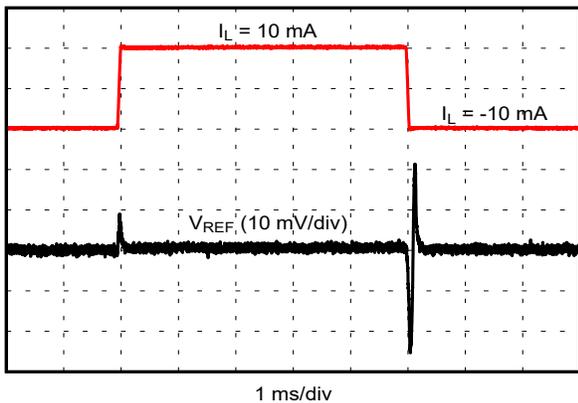


Figure 6-39. Load Transient Response ( $C_{OUT} = 1\mu\text{F}$ )

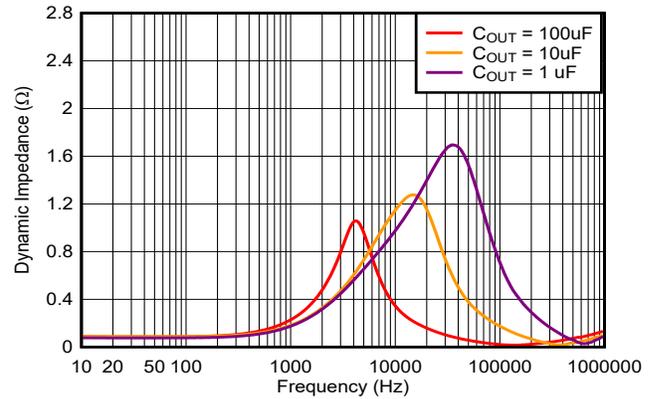


Figure 6-40. Output Impedance

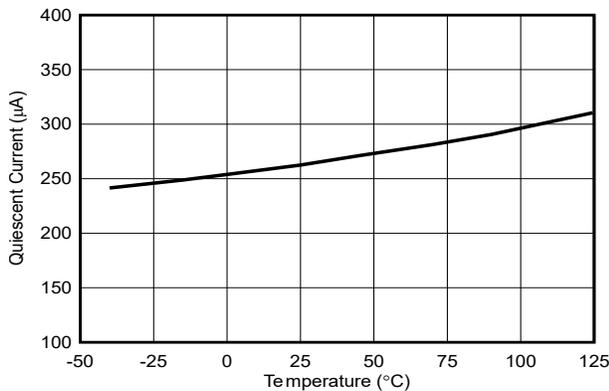


Figure 6-41. Quiescent Current vs Temperature

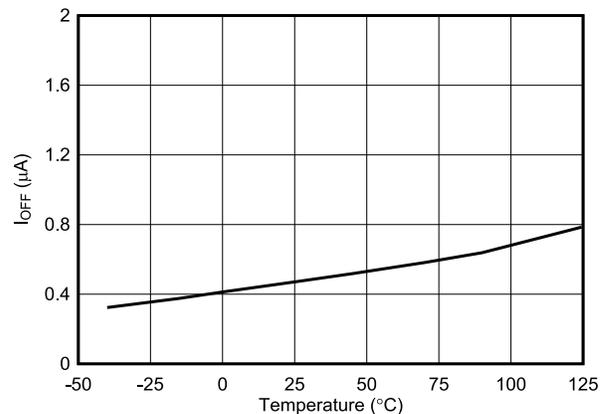


Figure 6-42. Shutdown Current vs Temperature

### 6.8 Typical Characteristics: REF50xxEI (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_{IN} = V_{EN} = V_{OUT} + 0.5\text{V}$ ,  $I_L = 0\text{mA}$ ,  $C_{Out} = 10\mu\text{F}$ ,  $C_{NR} = \text{Open}$ ,  $C_{IN} = 0.1\mu\text{F}$ ,

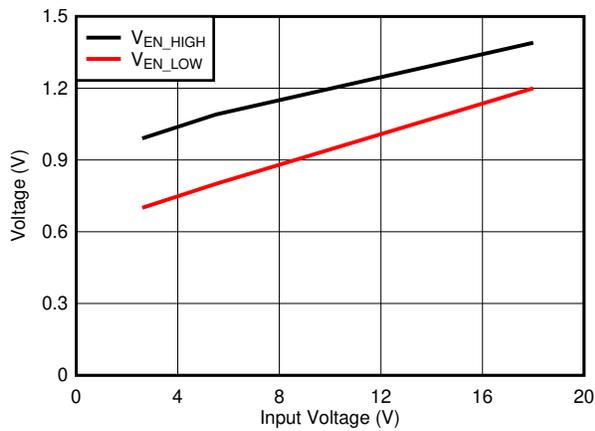


Figure 6-43. Enable Threshold vs  $V_{IN}$

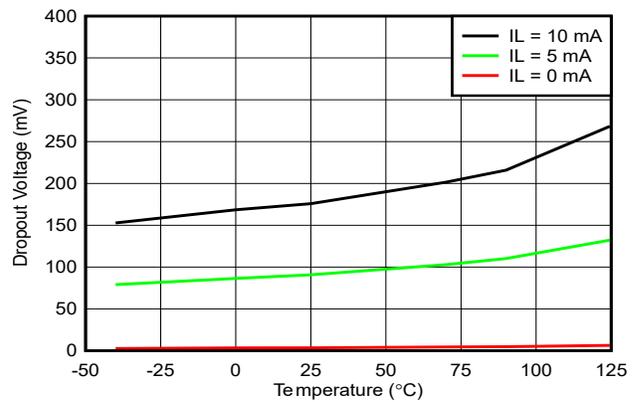


Figure 6-44. Dropout Voltage vs Temperature

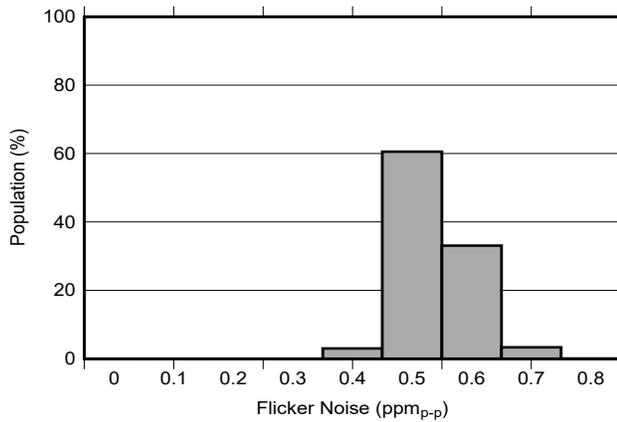


Figure 6-45. 0.1Hz to 10Hz Voltage Noise Distribution ( $C_{NR} = \text{Open}$ )

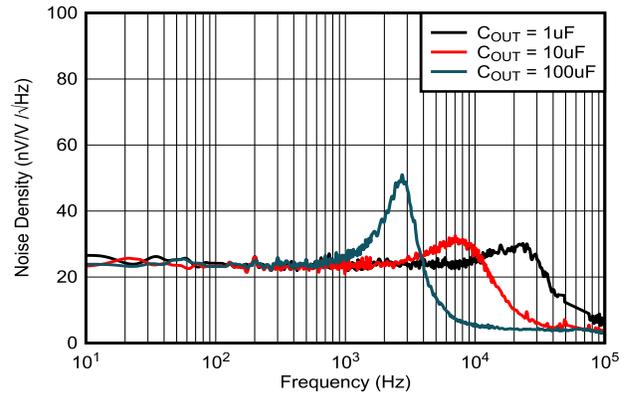


Figure 6-46. Noise Performance 10Hz to 100kHz ( $C_{NR} = \text{Open}$ )

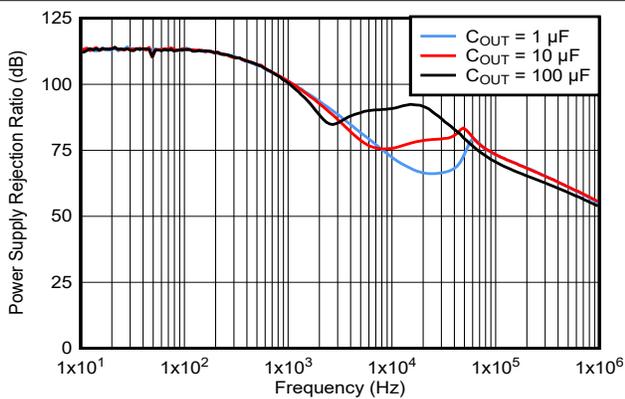


Figure 6-47. Power-Supply Rejection Ratio vs Frequency

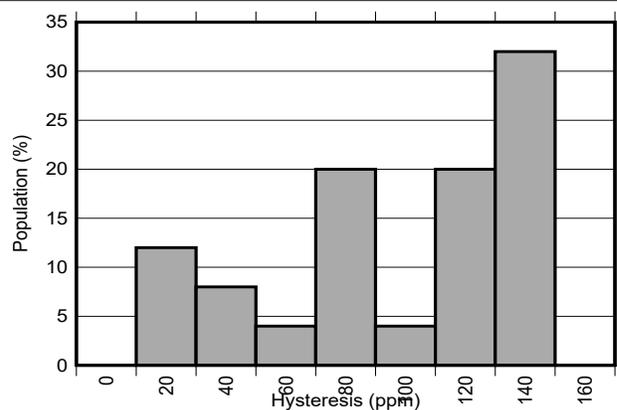
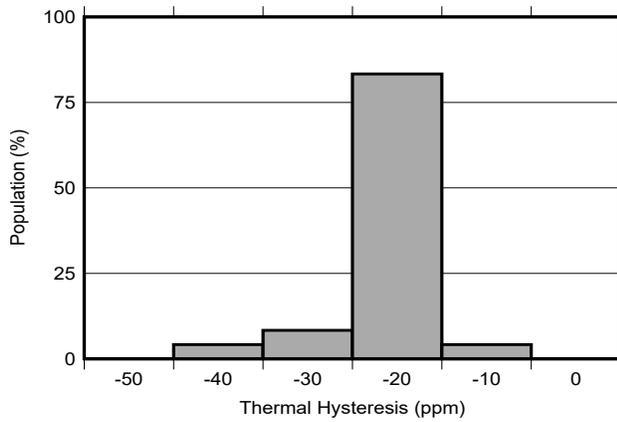


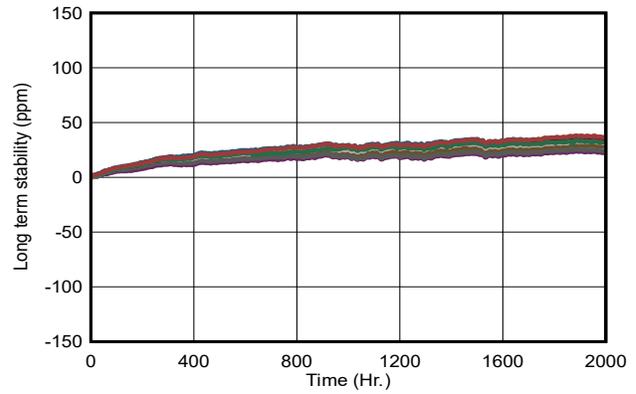
Figure 6-48. Thermal Hysteresis Distribution: Cycle 1 ( $-40^\circ\text{C}$  to  $125^\circ\text{C}$ )

### 6.8 Typical Characteristics: REF50xxEI (continued)

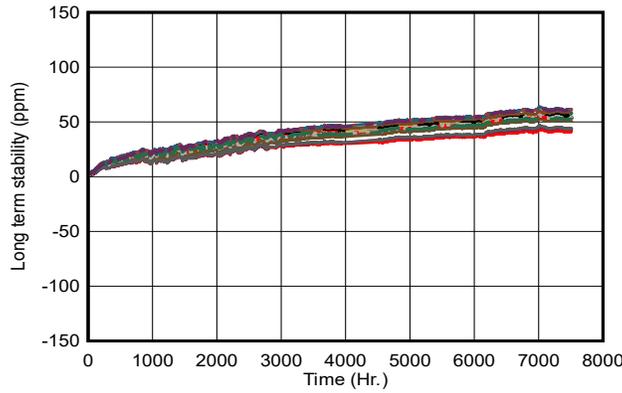
at  $T_A = 25^\circ\text{C}$ ,  $V_{IN} = V_{EN} = V_{OUT} + 0.5\text{V}$ ,  $I_L = 0\text{mA}$ ,  $C_{Out} = 10\mu\text{F}$ ,  $C_{NR} = \text{Open}$ ,  $C_{IN} = 0.1\mu\text{F}$ ,



**Figure 6-49. Thermal Hysteresis Distribution: Cycle 2 (-40°C to 125°C)**



**Figure 6-50. Long-Term Stability (First 2000 Hours)**



**Figure 6-51. Long-Term Stability (7500 hours)**

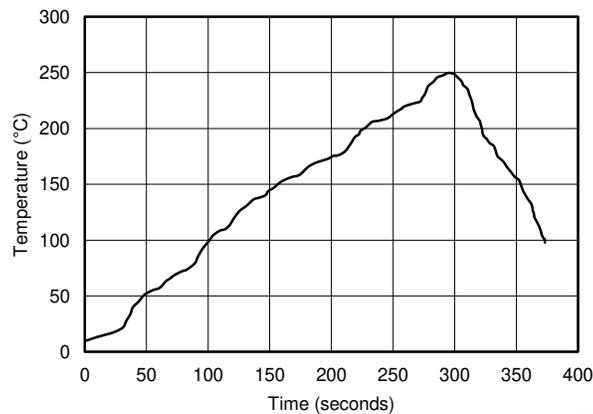
## 7 Parameter Measurement Information

### 7.1 Solder Heat Shift

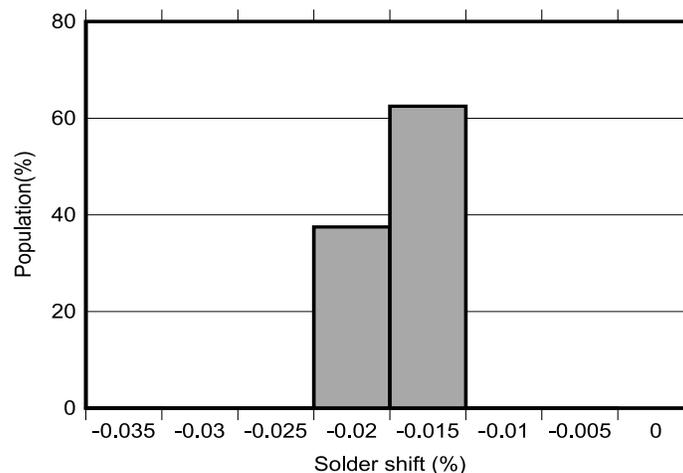
The materials used in manufacturing the REF50xx have differing coefficients of thermal expansion, resulting in stress on the device die when the part is heated. Mechanical and thermal stress on the device can cause the output voltages to shift, degrading the initial accuracy and drift specifications of the product. Reflow soldering is a common cause of this error.

To illustrate this effect, 36 devices are soldered on printed-circuit-boards using lead-free solder paste and the paste manufacturer suggested reflow profile. [Figure 7-1](#) shows the reflow profile. The printed-circuit-board is comprised of FR4 material. The board thickness is 0.8mm and the area is 13mm × 13mm.

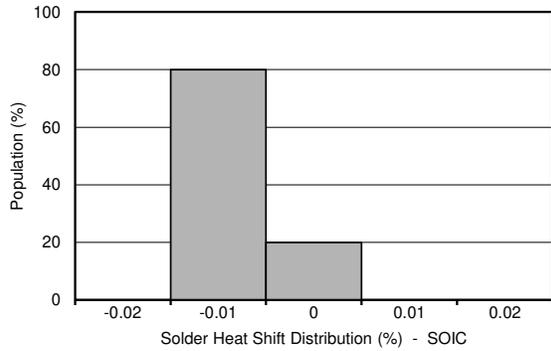
The reference voltage is measured before and after the reflow process across temperature; the typical shift of accuracy and drift is displayed in [Figure 7-2](#) for REF50xxEI and [Figure 7-3](#) through [Figure 7-10](#) for REF50xx. Although all tested units exhibit very low shifts, higher shifts are also possible depending on the size, thickness, and material of the printed-circuit-board. An important note is that the histograms display the typical shift for exposure to a single reflow profile. Exposure to multiple reflows, as is common on printed circuit boards (PCBs) with surface-mount components on both sides, causes additional shifts in the output bias voltage. If the PCB is exposed to multiple reflows, then solder the device in the last pass to minimize device exposure to thermal stress.



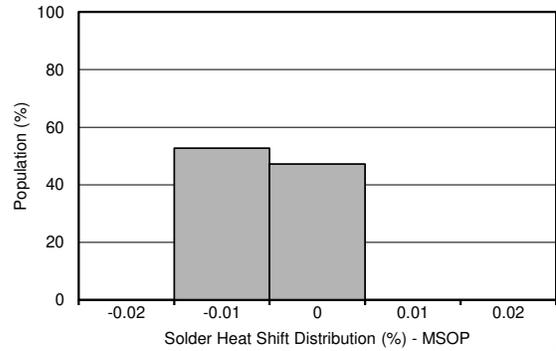
**Figure 7-1. Reflow Profile**



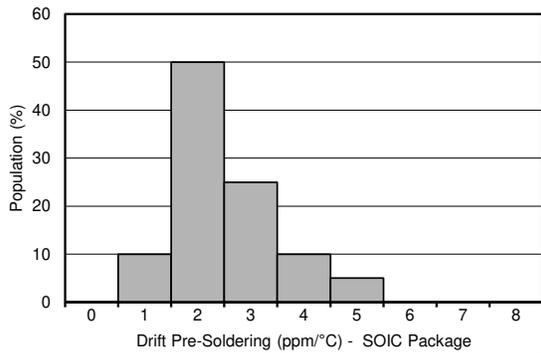
**Figure 7-2. Solder Heat Shift Distribution (%), REF50xxEI**



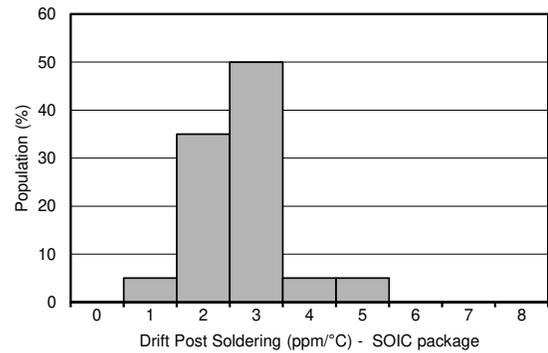
**Figure 7-3. Solder Heat Shift Distribution (%), SOIC Package**



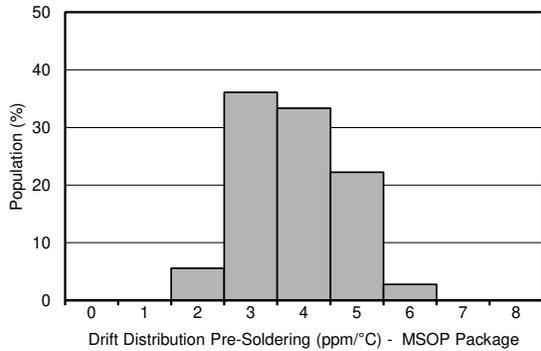
**Figure 7-4. Solder Heat Shift Distribution (%), VSSOP Package**



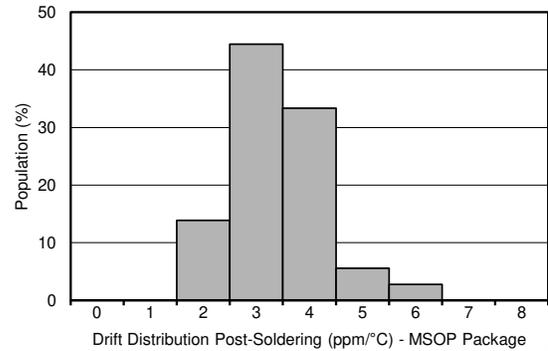
**Figure 7-5. Drift Pre-Soldering Distribution, SOIC Package**



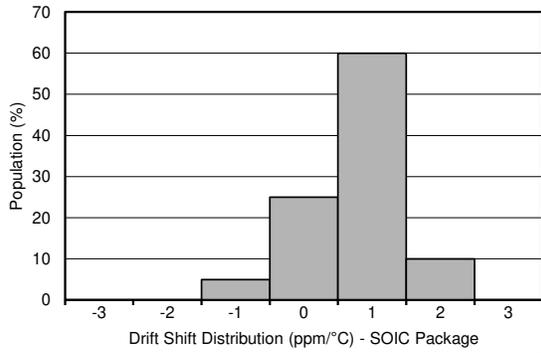
**Figure 7-6. Drift Post Soldering Distribution, SOIC Package**



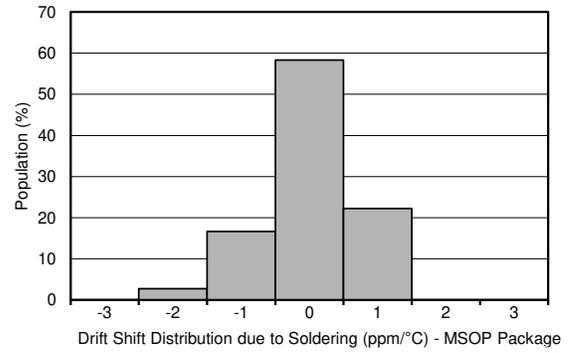
**Figure 7-7. Drift Distribution Pre-Soldering, VSSOP Package**



**Figure 7-8. Drift Distribution Post-Soldering, VSSOP Package**



**Figure 7-9. Drift Shift Distribution, SOIC Package**



**Figure 7-10. Drift Shift Distribution, VSSOP Package**

## 8 Detailed Description

### 8.1 Overview

The REF50xx is family of low-noise, precision band-gap voltage references designed for excellent initial voltage accuracy and drift. See [Section 8.2](#) for a simplified block diagram of the REF50xx.

### 8.2 Functional Block Diagram

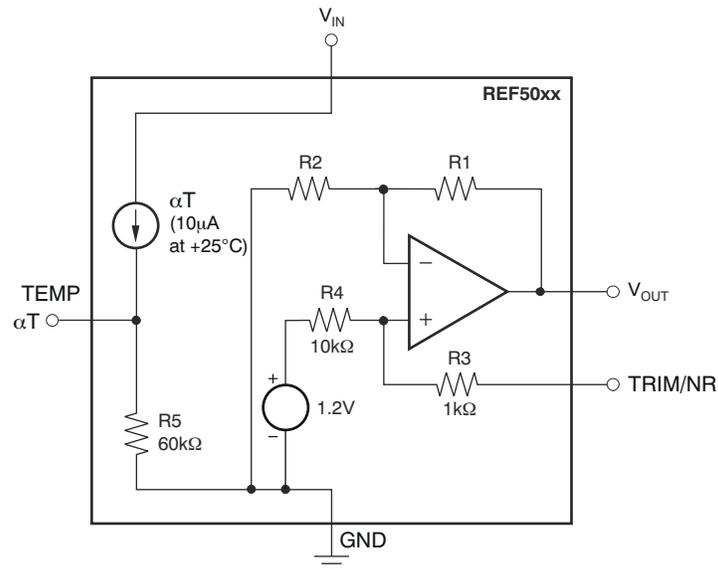


Figure 8-1. REF50xxI, REF50xxAI Block Diagram

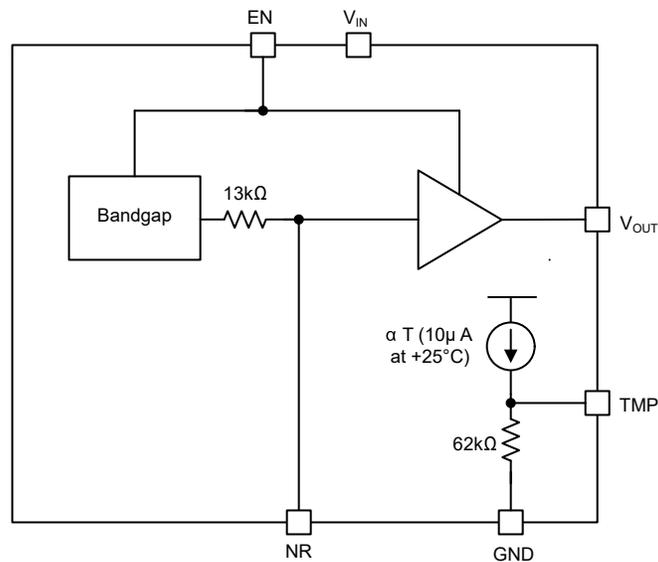


Figure 8-2. REF50xxEI Block Diagram

## 8.3 Feature Description

### 8.3.1 Temperature Monitoring

The temperature output terminal (TEMP, pin 3) provides a temperature-dependent voltage output with approximately 60kΩ source impedance. As illustrated in Figure 6-8, the output voltage follows the nominal relationship:

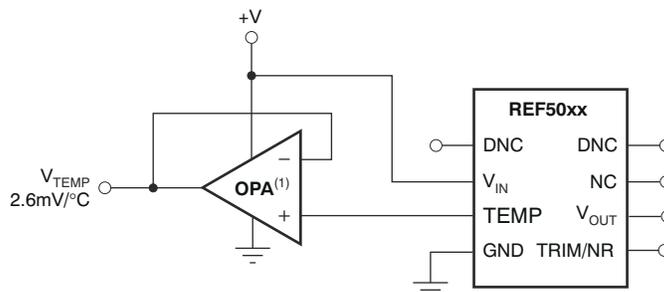
$$\text{REF50xxI, REF50xxAI: } V_{\text{TEMP PIN}} = 509\text{mV} + 2.64 \times T(^{\circ}\text{C}) \quad (1)$$

$$\text{REF50xxEI: } V_{\text{TEMP PIN}} = 625\text{mV} + 2.64 \times T(^{\circ}\text{C}) \quad (2)$$

The TEMP pin indicates general chip temperature, accurate to approximately  $\pm 15^{\circ}\text{C}$ . Although not generally suitable for accurate temperature measurements, use the TEMP pin to indicate temperature changes or for temperature compensation of analog circuitry. A temperature change of  $30^{\circ}\text{C}$  corresponds to an approximate 79mV change in voltage at the TEMP pin.

The TEMP pin has high-output impedance (see Section 8.2). Loading the TEMP pin with a low-impedance circuit induces a measurement error; however, the pin does not have any effect on  $V_{\text{OUT}}$  accuracy.

To avoid errors caused by low-impedance loading, buffer the TEMP pin output with a suitable low-temperature drift op amp, such as the OPA333, OPA335, or OPA376, as shown in Figure 8-3.



NOTE: (1) Low drift op amp, such as the OPA333, OPA335, or OPA376.

**Figure 8-3. Buffering the TEMP Pin Output**

### 8.3.2 Temperature Drift

The REF50xx is designed for minimal drift error, which is defined as the change in output voltage over temperature. The drift is calculated using the box method, as calculated in Equation 3.

$$\text{Drift} = \left[ \frac{V_{\text{OUTMAX}} - V_{\text{OUTMIN}}}{V_{\text{OUT}} \times \text{Temperature Range}} \right] \times 10^6 (\text{ppm}) \quad (3)$$

The REF50xx features a maximum drift coefficient of 2.5ppm/ $^{\circ}\text{C}$  for the enhanced-grade version, 3ppm/ $^{\circ}\text{C}$  for the high-grade version, and 8ppm/ $^{\circ}\text{C}$  for the standard-grade version.

### 8.3.3 Thermal Hysteresis

Thermal hysteresis for the REF50xx is the change in output voltage after operating the device at 25°C, cycling the device through the specified temperature range, and returning to 25°C. Equation 4 shows thermal hysteresis.

$$V_{\text{HYST}} = \left[ \frac{|V_{\text{PRE}} - V_{\text{POST}}|}{V_{\text{NOM}}} \right] \times 10^6 (\text{ppm}) \quad (4)$$

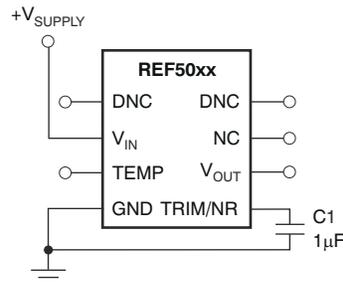
where

- $V_{\text{HYST}}$  = thermal hysteresis (ppm)
- $V_{\text{NOM}}$  = the specified output voltage
- $V_{\text{PRE}}$  = output voltage measured at 25°C pre-temperature cycling
- $V_{\text{POST}}$  = output voltage measurement after the device cycles from 25°C through the specified temperature range of –40°C to 125°C and returns to 25°C

### 8.3.4 Noise Performance

Typical 0.1Hz to 10Hz voltage noise for each member of the REF50xx family is specified Section 6.5 and Section 6.6. The noise voltage increases with output voltage and operating temperature. Use additional filtering to improve output noise levels. If using additional filtering, verify that the output impedance does not degrade performance.

For additional information about minimizing noise and maximizing performance in mixed-signal applications, such as data converters, refer to the [How a Voltage Reference Affects ADC Performance Part 1](#), [How a Voltage Reference Affects ADC Performance Part 2](#), and [How a Voltage Reference Affects ADC Performance Part 3](#) analog design journals.



**Figure 8-4. Noise Reduction Using the TRIM/NR Pin**

### 8.3.5 Long-Term Stability

Due to aging and environmental effects, all semiconductor devices experience physical changes of the semiconductor die and the packaging material over time. Over time, the changes and the associated package stress on the die cause the output voltage in precision voltage references to deviate. The value of such change is specified in the data sheet by a parameter called the long-term stability (also known as the long-term drift (LTD)). Equation 5 shows how LTD is calculated. Note that the LTD value is positive if the output voltage drifts higher over time and negative if the voltage drifts lower over time. Figure 6-23 through Figure 6-30 show the drift of the output voltage for REF50xx over the first 4000 operating hours.

$$\text{LTD}(\text{ppm})|_{t=n} = \frac{[V_{\text{OUT}}|_{t=0} - V_{\text{OUT}}|_{t=n}]}{V_{\text{OUT}}|_{t=0}} \times 10^6 \quad (5)$$

where

- $\text{LTD}(\text{ppm})|_{t=n}$  = long-term stability (ppm)
- $V_{\text{OUT}}|_{t=0}$  = output voltage at time = 0 hr
- $V_{\text{OUT}}|_{t=n}$  = output voltage at time = n hr

### 8.3.6 Output Adjustment Using the TRIM/NR Pin

The REF50xxI, REF50xxAI provides a very accurate, factory-trimmed voltage output. Adjust  $V_{OUT}$  using the trim and noise reduction pin (TRIM/NR, pin 5). Figure 8-5 shows a typical circuit that allows an output adjustment of  $\pm 15\text{mV}$ .

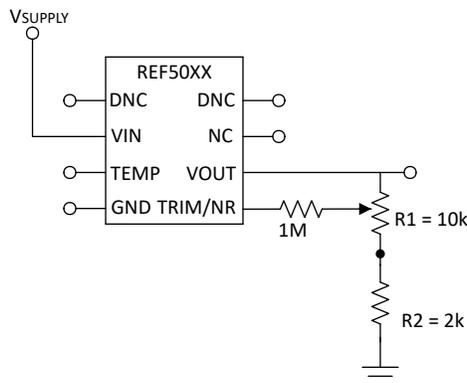


Figure 8-5.  $V_{OUT}$  Adjustment Using the TRIM/NR Pin

The REF50xx allows access to the band-gap through the TRIM/NR pin. Placing a capacitor from the TRIM/NR pin to GND (Figure 8-4) in combination with the internal  $R_3$  and  $R_4$  resistors creates a low-pass filter. A capacitance of  $1\mu\text{F}$  creates a low-pass filter with the corner frequency from 10Hz to 20Hz. A low-pass filter decreases the overall noise measured on the  $V_{OUT}$  pin by half. A higher capacitance results in a lower filter cutoff frequency, further reducing output noise. Using this capacitor increases start-up time.

## 8.4 Device Functional Modes

### 8.4.1 Basic Connections

Figure 8-6 shows the typical connections for the REF50xx. TI recommends a supply bypass capacitor ranging from  $1\mu\text{F}$  to  $10\mu\text{F}$ . Confirm that an output capacitor ( $C_L$ ) is connected from  $V_{OUT}$  to GND. For output stability, verify that the equivalent series resistance (ESR) value of  $C_L$  less than or equal to  $1.5\Omega$ . To minimize noise, the recommended ESR of  $C_L$  is from  $1\Omega$  and  $1.5\Omega$ .

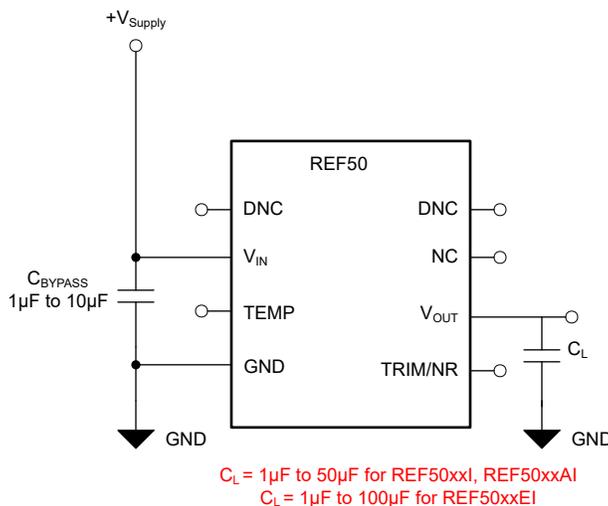


Figure 8-6. Basic Connections

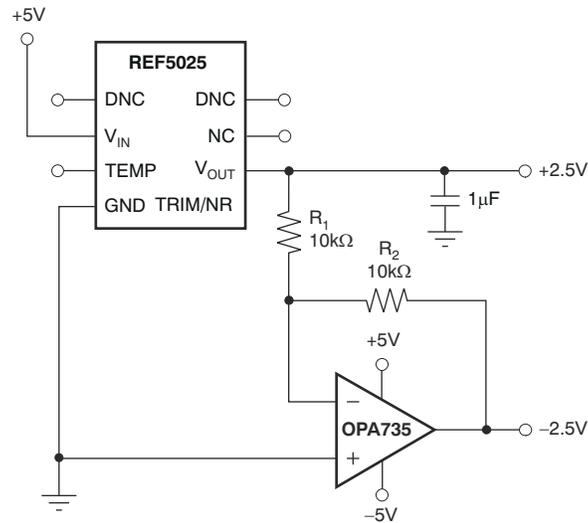
### 8.4.2 Supply Voltage

The REF50xx family of voltage references features extremely low dropout voltage. With the exception of the REF5020, which has a minimum supply requirement of 2.7V, operate the family of references with a supply of

200mV more than the output voltage in an unloaded condition. For loaded conditions, [Figure 6-6](#) shows a typical dropout voltage versus load plot.

### 8.4.3 Negative Reference Voltage

For applications requiring a negative and positive reference voltage, use REF50xx and [OPA735](#) to provide a dual-supply reference from a 5V supply. [Figure 8-7](#) shows the REF5025 used to provide a 2.5V supply reference voltage. The low-drift performance of the REF50xx complements the low offset voltage and zero drift of the OPA735 to provide an accurate solution for split-supply applications. Verify that the temperature coefficients of  $R_1$  and  $R_2$  match.



NOTE: Bypass capacitors not shown.

**Figure 8-7. REF5025 and OPA735 Create Positive and Negative Reference Voltages**

## 9 Applications and Implementation

### Note

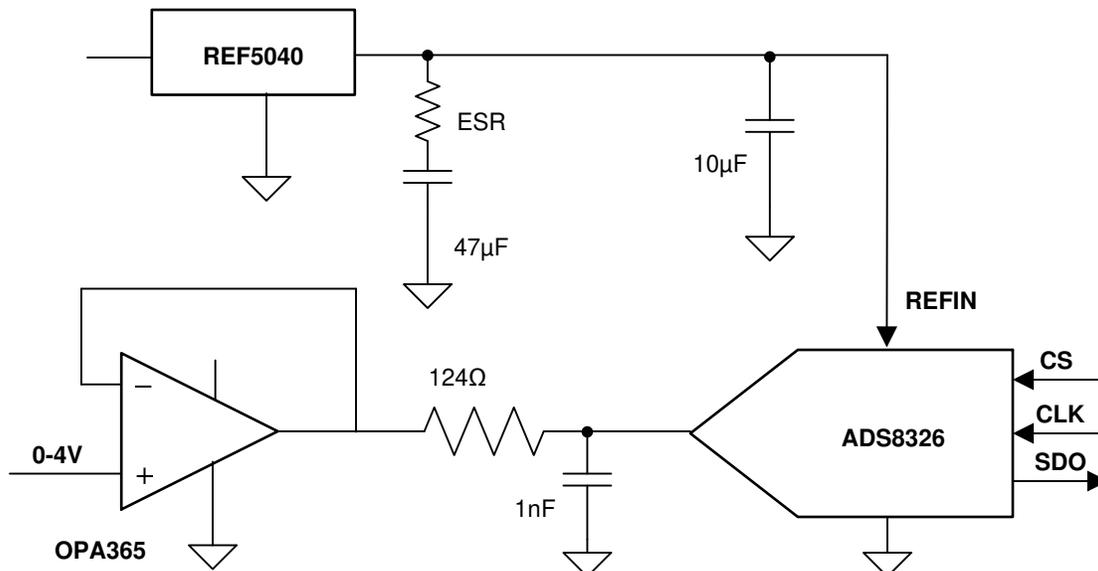
Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 9.1 Application Information

Data acquisition systems often require stable voltage references to maintain accuracy. The REF50xx family features low noise, very low drift, and high initial accuracy for high-performance data converters. [Figure 9-1](#) shows the REF5040 in a basic data acquisition system.

### 9.2 Typical Applications

#### 9.2.1 16-bit, 250KSPS Data Acquisition System



**Figure 9-1. Complete Data Acquisition System Using the REF50xx**

#### 9.2.1.1 Design Requirements

When using the REF50xx in the design, select a proper output capacitor that does not create gain peaking, thereby increasing total system noise. At the same time, select a capacitor that provides the required filtering performance for the system. Add input bypass capacitor and noise reduction capacitors for peak performances. During the design of the data acquisition system, give equal consideration to the buffering analog input signal and the reference voltage. Having a properly designed input buffer with an associated RC filter is a necessary requirement for good performance of the data acquisition system.

#### 9.2.1.2 Detailed Design Procedure

The OPA365 is used to drive the 16-bit analog-to-digital converter (ADS8326). The RC filter at the output of the OPA365 is used to reduce the charge kick-back created by the opening and closing of the sampling switch inside the ADC. Design the RC filter such that the voltage at the sampling capacitor settles to 16-bit accuracy within the acquisition time of the ADC. Verify that the bandwidth of the driving amplifier is at least be four times the bandwidth of the RC filter.

The REF5040 is used to drive the REF pin of the ADS8326. Proper selection of voltage reference output capacitor is very important for this design. Very low equivalent series resistance (ESR) creates gain-peaking,

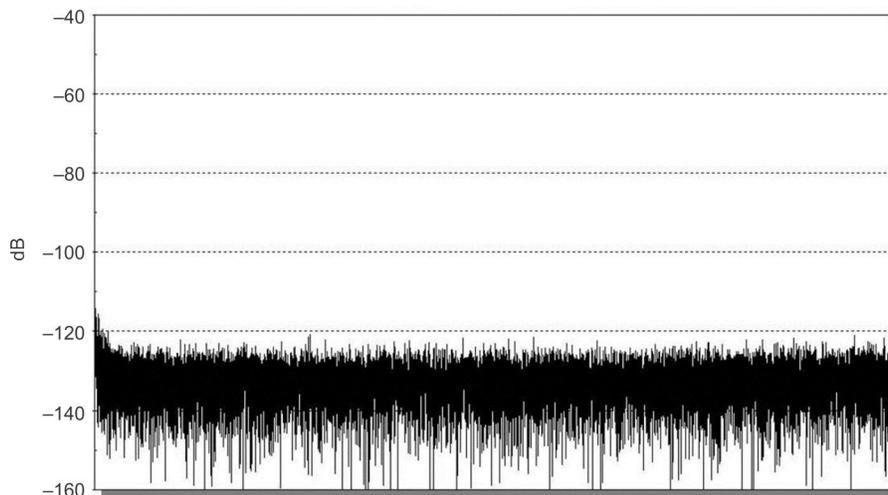
which degrades SNR of the total system. If the ESR of the capacitor is not enough, then an additional resistor must be added in series with the output capacitor. A capacitance of 1µF can connect to the NR pin to reduce band-gap noise of the REF50xx.

Table 9-1 shows SNR measurements using different RC filters at the output of the OPA365, different values of output capacitor for the REF50xx and different values of capacitors at the TRIM/NR pin.

**Table 9-1. Data Acquisition Measurement Results for Different Conditions**

|                          | TEST CONDITION 1 | TEST CONDITION 2 |
|--------------------------|------------------|------------------|
| OPA365 RC filter         | 124Ω, 1nF        | 124Ω, 1nF        |
| REF5040 output capacitor | 10µF             | 10µF + 47µF      |
| TRIM/NR pin capacitor    | 0µF              | 1µF              |
| SNR                      | 86.7dB           | 92.8dB           |

### 9.2.1.3 Application Curve



**Figure 9-2. FFT Plot-Noise Floor of Data Acquisition System**

## 9.3 Power Supply Recommendations

The REF50xx family of voltage references features extremely low dropout voltage. With the exception of the REF5020, which has a minimum supply requirement of 2.7V, the REF50xx family of voltage references operates with a supply of 200mV more than the output voltage in an unloaded condition. For loaded conditions, Figure 6-6 provides a typical dropout voltage versus load plot. TI recommends a supply bypass capacitor ranging from 1µF to 50µF for REF50xxI and REF50xxAI. TI recommends a supply bypass capacitor ranging from 1µF to 100µF for REF50xxEI.

## 9.4 Layout

### 9.4.1 Layout Guidelines

#### 9.4.1.1 REF50xxI, REF50xxAI Layout Guidelines

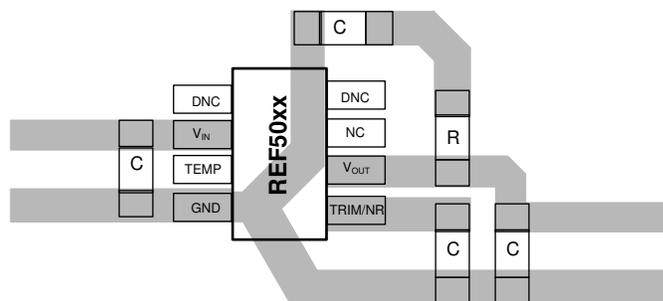
- Place the power-supply bypass capacitor as closely as possible to the supply and ground pins. The recommended value of this bypass capacitor is from 1µF to 10µF. If necessary, add decoupling capacitance to compensate for noisy or high-impedance power supplies.
- Place a 1µF noise filtering capacitor between the NR pin and ground.
- Verify that the output decouples with a 1µF to 50µF capacitor. A resistor in series with the output capacitor is optional. For better noise performance, the recommended ESR on the output capacitor is from 1Ω to 1.5Ω.

- Add a high-frequency, 1µF capacitor in parallel between the output and ground to filter noise and help with switching loads as data converters.

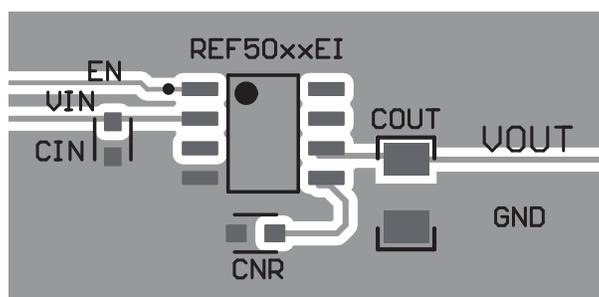
#### 9.4.1.2 REF50xxEI Layout Guidelines

- Place the power-supply bypass capacitor as close as possible to the supply and ground pins. The recommended value of this bypass capacitor is from 0.1µF to 10µF. If necessary, add decoupling capacitance to compensate for noisy or high-impedance power supplies. Verify that the smallest capacitor is placed closest to the device.
- Place a 0.1µF to 1µF class 1 noise filtering capacitor between the NR pin and ground.
- Verify that the output decouples with a 1µF to 100µF low ESR (maximum 1Ω) capacitor.

#### 9.4.2 Layout Example



**Figure 9-3. Layout Example for REF50xxI, REF50xxAI**



**Figure 9-4. Layout Example for REF50xxEI**

#### 9.4.3 Power Dissipation

The REF50xx family is specified to deliver current loads of ±10mA over the specified input voltage range. The temperature of the device increases according to [Equation 6](#):

$$T_J = T_A + P_D \times \theta_{JA} \quad (6)$$

where

- $T_J$  = junction temperature (°C)
- $T_A$  = ambient temperature (°C)
- $P_D$  = power dissipated (W)
- $\theta_{JA}$  = junction-to-ambient thermal resistance (°C/W)

Establish that the REF50xx junction temperature does not exceed the absolute maximum rating of 150°C.

## 10 Device and Documentation Support

### 10.1 Documentation Support

#### 10.1.1 Related Documentation

For related documentation see the following:

- Texas Instruments, [0.05µV/°C \(Maximum\), Single-Supply CMOS Zero-Drift Series Operational Amplifier](#) data sheet
- Texas Instruments, [REF5020 PSpice Model](#)
- Texas Instruments, [REF5020 TINA-TI Reference Design](#)
- Texas Instruments, [REF5020 TINA-TI Spice Model](#)
- Texas Instruments, [INA270 PSpice Model](#)
- Texas Instruments, [INA270 TINA-TI Reference Design](#)
- Texas Instruments, [INA270 TINA-TI Spice Model](#)

### 10.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](#). Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 10.3 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 10.4 Trademarks

TI E2E™ is a trademark of Texas Instruments.  
All trademarks are the property of their respective owners.

### 10.5 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 11 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| <b>Changes from Revision N (March 2025) to Revision O (October 2025)</b>   | <b>Page</b> |
|--|-------------|
| • Updated the numbering format for tables, figures, and cross-references throughout the document.....            | 1           |
| • Deleted paragraph describing REF50xxEI voltage range.....  | 1           |
| • Updated <a href="#">Table 4-1</a> REF50xxE information.....  | 3           |
| • Deleted Product Preview tag from REF5030EID, REF5040EID, and REF5045EID devices.....                           | 3           |
| • Added <a href="#">Table 4-2</a> .....  | 3           |
| • Updated pin information from: REF50xxA to: REF50xxAI.....  | 4           |
| • Updated pin information from: REF50xxE to: REF50xxEI.....  | 4           |
| • Updated title from: Electrical Characteristics REF50 to: Electrical Characteristics REF50xxA and REF50xxAI     | 7           |
| • Changed from: Layout Guidelines to: REF50xxEI Layout Guidelines and REF50xxI, REF50xxAI Layout Guidelines..... | 30          |

| <b>Changes from Revision M (December 2024) to Revision N (March 2025)</b>   | <b>Page</b> |
|---|-------------|
| • Update datasheet header folder link from REF50XX to REF50 and REF50E..... | 1           |

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">REF5010AID</a>    | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5010<br>A    |
| REF5010AID.A                  | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5010<br>A    |
| <a href="#">REF5010AIDGKR</a> | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI   Nipdau                     | Level-2-260C-1 YEAR               | -40 to 125   | R50G                |
| REF5010AIDGKR.A               | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R50G                |
| <a href="#">REF5010AIDGKT</a> | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI   Nipdau                     | Level-2-260C-1 YEAR               | -40 to 125   | R50G                |
| REF5010AIDGKT.A               | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50G                |
| <a href="#">REF5010AIDR</a>   | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5010<br>A    |
| REF5010AIDR.A                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5010<br>A    |
| REF5010AIDRG4                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5010<br>A    |
| REF5010AIDRG4.A               | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5010<br>A    |
| <a href="#">REF5010ID</a>     | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5010         |
| REF5010ID.A                   | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5010         |
| <a href="#">REF5010IDGKR</a>  | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50G                |
| REF5010IDGKR.A                | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50G                |
| <a href="#">REF5010IDGKT</a>  | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50G                |
| REF5010IDGKT.A                | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50G                |
| <a href="#">REF5020AID</a>    | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5020<br>A    |

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| REF5020AID.A                  | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5020<br>A    |
| <a href="#">REF5020AIDGKR</a> | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI   Nipdau                     | Level-2-260C-1 YEAR               | -40 to 125   | R50A                |
| REF5020AIDGKR.A               | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R50A                |
| <a href="#">REF5020AIDGKT</a> | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50A                |
| REF5020AIDGKT.A               | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50A                |
| <a href="#">REF5020AIDR</a>   | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5020<br>A    |
| REF5020AIDR.A                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5020<br>A    |
| <a href="#">REF5020ID</a>     | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5020         |
| REF5020ID.A                   | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5020         |
| <a href="#">REF5020IDGKR</a>  | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50A                |
| REF5020IDGKR.A                | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50A                |
| <a href="#">REF5020IDGKT</a>  | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50A                |
| REF5020IDGKT.A                | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50A                |
| <a href="#">REF5020IDR</a>    | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5020         |
| REF5020IDR.A                  | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5020         |
| <a href="#">REF5025AID</a>    | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5025<br>A    |
| REF5025AID.A                  | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5025<br>A    |
| <a href="#">REF5025AIDGKR</a> | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI   Nipdau                     | Level-2-260C-1 YEAR               | -40 to 125   | R50B                |
| REF5025AIDGKR.A               | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R50B                |
| REF5025AIDGKRG4               | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R50B                |

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| REF5025AIDGKRG4.A             | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R50B                |
| <a href="#">REF5025AIDGKT</a> | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI   Nipdau                     | Level-2-260C-1 YEAR               | -40 to 125   | R50B                |
| REF5025AIDGKT.A               | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50B                |
| <a href="#">REF5025AIDR</a>   | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5025<br>A    |
| REF5025AIDR.A                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5025<br>A    |
| REF5025AIDR1G4                | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5025<br>A    |
| REF5025AIDR1G4.A              | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5025<br>A    |
| <a href="#">REF5025EIDR</a>   | Active        | Production           | SOIC (D)   8    | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R5025E              |
| REF5025EIDR.A                 | Active        | Production           | SOIC (D)   8    | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R5025E              |
| <a href="#">REF5025ID</a>     | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5025         |
| REF5025ID.A                   | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5025         |
| <a href="#">REF5025IDGKR</a>  | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50B                |
| REF5025IDGKR.A                | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50B                |
| <a href="#">REF5025IDGKT</a>  | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50B                |
| REF5025IDGKT.A                | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50B                |
| <a href="#">REF5025IDR</a>    | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5025         |
| REF5025IDR.A                  | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5025         |
| <a href="#">REF5030AID</a>    | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5030<br>A    |
| REF5030AID.A                  | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5030<br>A    |

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">REF5030AIDGKR</a> | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI   Nipdau                     | Level-2-260C-1 YEAR               | -40 to 125   | R50C                |
| REF5030AIDGKR.A               | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R50C                |
| REF5030AIDGKRG4               | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R50C                |
| REF5030AIDGKRG4.A             | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R50C                |
| <a href="#">REF5030AIDGKT</a> | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50C                |
| REF5030AIDGKT.A               | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50C                |
| <a href="#">REF5030AIDR</a>   | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5030<br>A    |
| REF5030AIDR.A                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5030<br>A    |
| REF5030AIDRG4                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5030<br>A    |
| REF5030AIDRG4.A               | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5030<br>A    |
| <a href="#">REF5030EIDR</a>   | Active        | Production           | SOIC (D)   8    | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R5030E              |
| <a href="#">REF5030ID</a>     | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5030         |
| REF5030ID.A                   | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5030         |
| <a href="#">REF5030IDGKR</a>  | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50C                |
| REF5030IDGKR.A                | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50C                |
| <a href="#">REF5030IDGKT</a>  | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50C                |
| REF5030IDGKT.A                | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50C                |
| <a href="#">REF5030IDR</a>    | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5030         |
| REF5030IDR.A                  | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5030         |
| <a href="#">REF5040AID</a>    | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5040<br>A    |

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| REF5040AID.A                  | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5040<br>A    |
| <a href="#">REF5040AIDGKR</a> | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI   Nipdau                     | Level-2-260C-1 YEAR               | -40 to 125   | R50D                |
| REF5040AIDGKR.A               | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R50D                |
| <a href="#">REF5040AIDGKT</a> | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI   Nipdau                     | Level-2-260C-1 YEAR               | -40 to 125   | R50D                |
| REF5040AIDGKT.A               | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50D                |
| REF5040AIDGKTG4               | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50D                |
| REF5040AIDGKTG4.A             | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50D                |
| <a href="#">REF5040AIDR</a>   | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5040<br>A    |
| REF5040AIDR.A                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5040<br>A    |
| REF5040AIDRG4                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5040<br>A    |
| REF5040AIDRG4.A               | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5040<br>A    |
| <a href="#">REF5040EIDR</a>   | Active        | Production           | SOIC (D)   8    | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R5040E              |
| <a href="#">REF5040ID</a>     | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5040         |
| REF5040ID.A                   | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5040         |
| <a href="#">REF5040IDGKR</a>  | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50D                |
| REF5040IDGKR.A                | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50D                |
| <a href="#">REF5040IDGKT</a>  | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50D                |
| REF5040IDGKT.A                | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50D                |
| <a href="#">REF5040IDR</a>    | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5040         |
| REF5040IDR.A                  | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5040         |

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">REF5045AID</a>    | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5045<br>A    |
| REF5045AID.A                  | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5045<br>A    |
| <a href="#">REF5045AIDGKR</a> | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI   Nipdau                     | Level-2-260C-1 YEAR               | -40 to 125   | R50E                |
| REF5045AIDGKR.A               | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R50E                |
| <a href="#">REF5045AIDGKT</a> | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI   Nipdau                     | Level-2-260C-1 YEAR               | -40 to 125   | R50E                |
| REF5045AIDGKT.A               | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50E                |
| <a href="#">REF5045AIDR</a>   | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5045<br>A    |
| REF5045AIDR.A                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5045<br>A    |
| <a href="#">REF5045ID</a>     | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5045         |
| REF5045ID.A                   | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5045         |
| <a href="#">REF5045IDGKR</a>  | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50E                |
| REF5045IDGKR.A                | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50E                |
| <a href="#">REF5045IDGKT</a>  | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50E                |
| REF5045IDGKT.A                | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50E                |
| <a href="#">REF5045IDR</a>    | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5045         |
| REF5045IDR.A                  | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5045         |
| <a href="#">REF5050AID</a>    | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5050<br>A    |
| REF5050AID.A                  | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5050<br>A    |
| <a href="#">REF5050AIDGKR</a> | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI   Nipdau                     | Level-2-260C-1 YEAR               | -40 to 125   | R50F                |

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| REF5050AIDGKR.A               | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50F                |
| REF5050AIDGKRG4               | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R50F                |
| REF5050AIDGKRG4.A             | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R50F                |
| <a href="#">REF5050AIDGKT</a> | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI   Nipdau                     | Level-2-260C-1 YEAR               | -40 to 125   | R50F                |
| REF5050AIDGKT.A               | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50F                |
| <a href="#">REF5050AIDR</a>   | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5050<br>A    |
| REF5050AIDR.A                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5050<br>A    |
| <a href="#">REF5050EIDR</a>   | Active        | Production           | SOIC (D)   8    | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R5050E              |
| REF5050EIDR.A                 | Active        | Production           | SOIC (D)   8    | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | R5050E              |
| <a href="#">REF5050ID</a>     | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5050         |
| REF5050ID.A                   | Active        | Production           | SOIC (D)   8    | 75   TUBE             | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5050         |
| <a href="#">REF5050IDGKR</a>  | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50F                |
| REF5050IDGKR.A                | Active        | Production           | VSSOP (DGK)   8 | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50F                |
| <a href="#">REF5050IDGKT</a>  | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50F                |
| REF5050IDGKT.A                | Active        | Production           | VSSOP (DGK)   8 | 250   SMALL T&R       | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | R50F                |
| <a href="#">REF5050IDR</a>    | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5050         |
| REF5050IDR.A                  | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | Call TI                              | Level-2-260C-1 YEAR               | -40 to 125   | REF<br>5050         |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

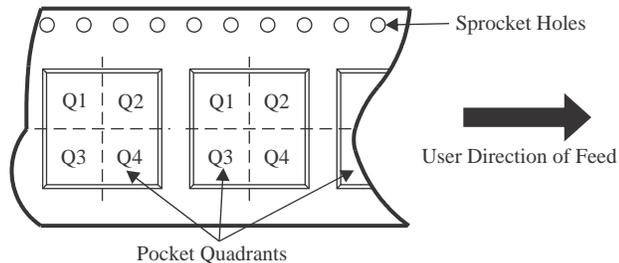
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## TAPE AND REEL INFORMATION



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| REF5010AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5010AIDGKT   | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5010AIDR     | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5010AIDRG4   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5010IDGKR    | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5010IDGKT    | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5020AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5020AIDGKT   | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5020AIDR     | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5020IDGKR    | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5020IDGKT    | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5020IDR      | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5025AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5025AIDGKRG4 | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5025AIDGKT   | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5025AIDR     | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |

| Device          | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| REF5025AIDR1G4  | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5025EIDR     | SOIC         | D               | 8    | 3000 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5025IDGKR    | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5025IDGKT    | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5025IDR      | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5030AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5030AIDGKRG4 | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5030AIDGKT   | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5030AIDR     | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5030AIDRG4   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5030EIDR     | SOIC         | D               | 8    | 3000 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5030IDGKR    | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5030IDGKT    | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5030IDR      | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5040AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5040AIDGKT   | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5040AIDGKTG4 | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5040AIDR     | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5040AIDRG4   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5040EIDR     | SOIC         | D               | 8    | 3000 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5040IDGKR    | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5040IDGKT    | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5040IDR      | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5045AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5045AIDGKT   | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5045AIDR     | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5045IDGKR    | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5045IDGKT    | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5045IDR      | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5050AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5050AIDGKRG4 | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5050AIDGKT   | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5050AIDR     | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5050EIDR     | SOIC         | D               | 8    | 3000 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF5050IDGKR    | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5050IDGKT    | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| REF5050IDR      | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |

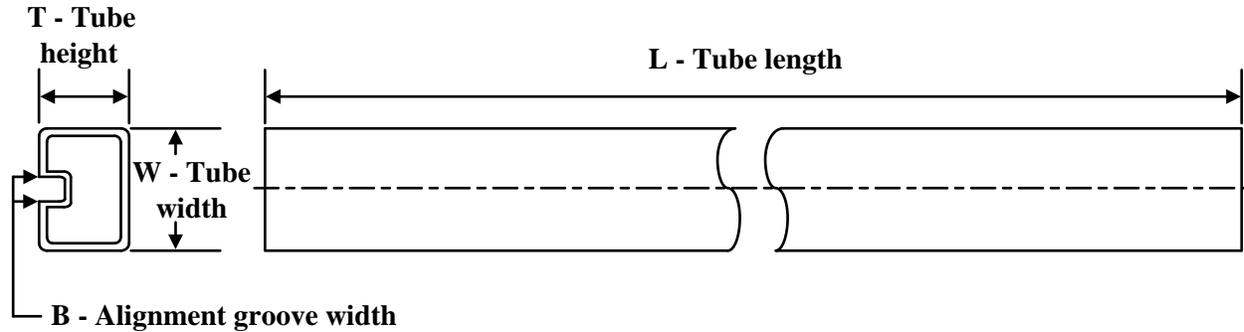
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| REF5010AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5010AIDGKT   | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5010AIDR     | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5010AIDRG4   | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5010IDGKR    | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5010IDGKT    | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5020AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5020AIDGKT   | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5020AIDR     | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5020IDGKR    | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5020IDGKT    | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5020IDR      | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5025AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5025AIDGKRG4 | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5025AIDGKT   | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5025AIDR     | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5025AIDR1G4  | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5025EIDR     | SOIC         | D               | 8    | 3000 | 353.0       | 353.0      | 32.0        |

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| REF5025IDGKR    | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5025IDGKT    | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5025IDR      | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5030AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5030AIDGKRG4 | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5030AIDGKT   | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5030AIDR     | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5030AIDRG4   | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5030EIDR     | SOIC         | D               | 8    | 3000 | 353.0       | 353.0      | 32.0        |
| REF5030IDGKR    | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5030IDGKT    | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5030IDR      | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5040AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5040AIDGKT   | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5040AIDGKTG4 | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5040AIDR     | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5040AIDRG4   | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5040EIDR     | SOIC         | D               | 8    | 3000 | 353.0       | 353.0      | 32.0        |
| REF5040IDGKR    | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5040IDGKT    | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5040IDR      | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5045AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5045AIDGKT   | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5045AIDR     | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5045IDGKR    | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5045IDGKT    | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5045IDR      | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5050AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5050AIDGKRG4 | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5050AIDGKT   | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5050AIDR     | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5050EIDR     | SOIC         | D               | 8    | 3000 | 353.0       | 353.0      | 32.0        |
| REF5050IDGKR    | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| REF5050IDGKT    | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| REF5050IDR      | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |

**TUBE**


\*All dimensions are nominal

| Device       | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| REF5010AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5010AID.A | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5010ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5010ID.A  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5020AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5020AID.A | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5020ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5020ID.A  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5025AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5025AID.A | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5025ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5025ID.A  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5030AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5030AID.A | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5030ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5030ID.A  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5040AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5040AID.A | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5040ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5040ID.A  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5045AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5045AID.A | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5045ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5045ID.A  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5050AID   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5050AID.A | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5050ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| REF5050ID.A  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |

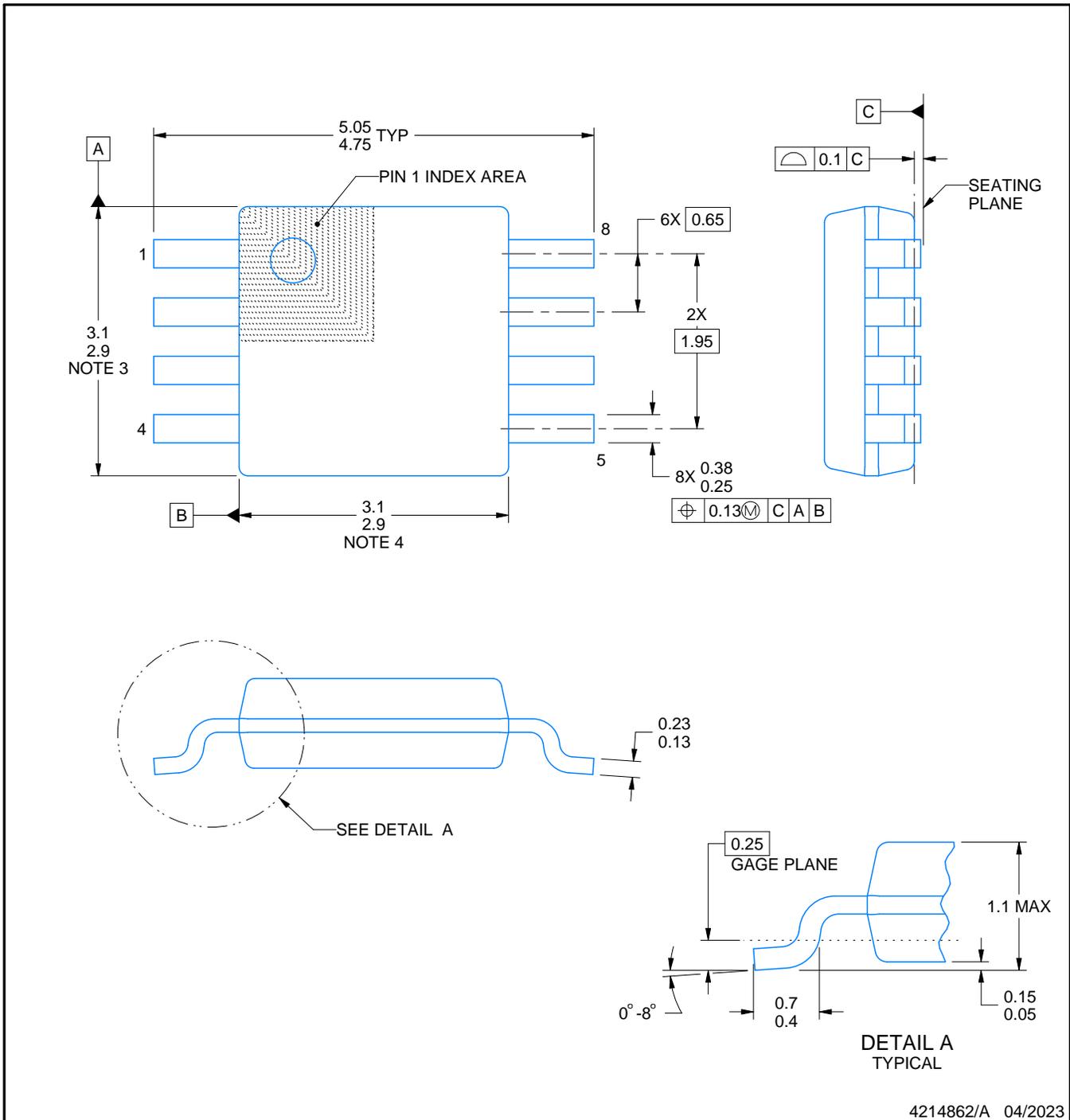
# DGK0008A



# PACKAGE OUTLINE

VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



4214862/A 04/2023

**NOTES:**

PowerPAD is a trademark of Texas Instruments.

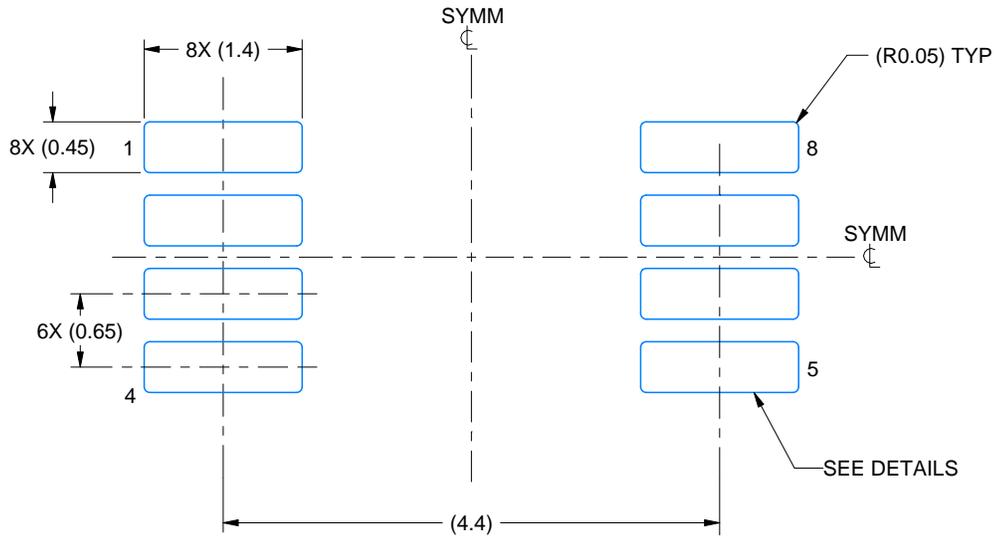
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-187.

# EXAMPLE BOARD LAYOUT

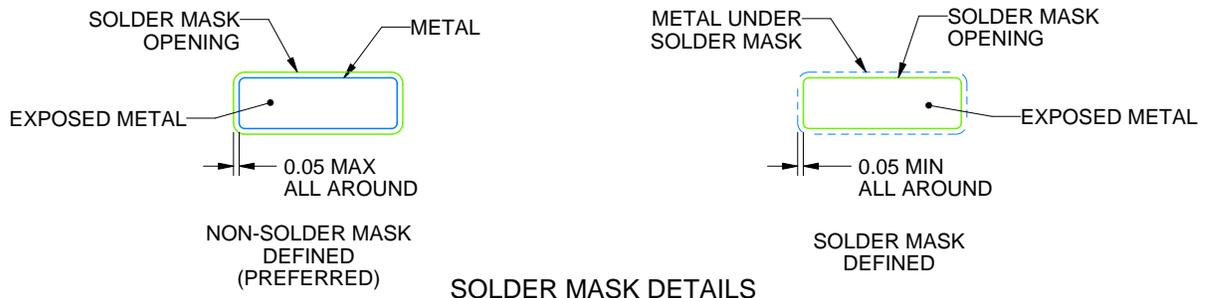
DGK0008A

™ VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 15X



4214862/A 04/2023

NOTES: (continued)

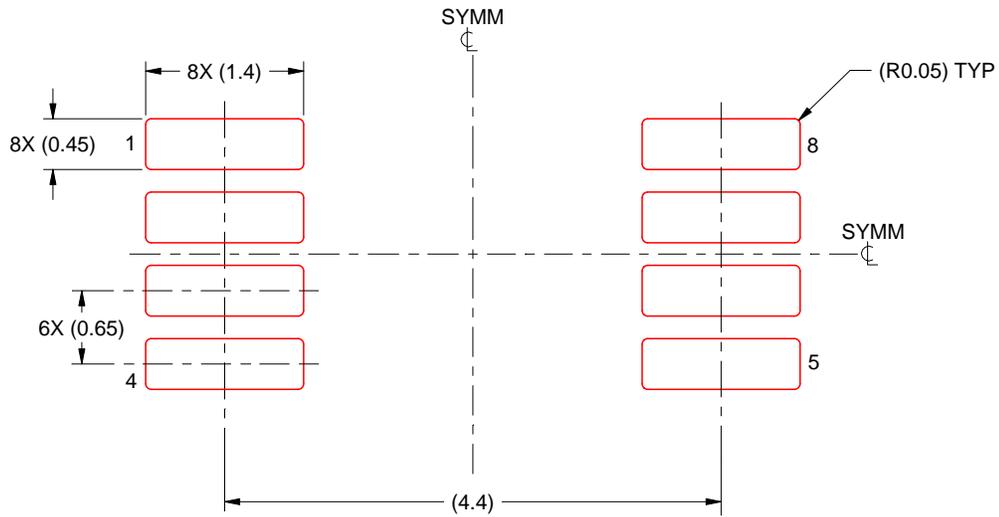
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
8. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.
9. Size of metal pad may vary due to creepage requirement.

# EXAMPLE STENCIL DESIGN

DGK0008A

<sup>TM</sup> VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE

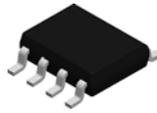


SOLDER PASTE EXAMPLE  
SCALE: 15X

4214862/A 04/2023

NOTES: (continued)

11. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
12. Board assembly site may have different recommendations for stencil design.

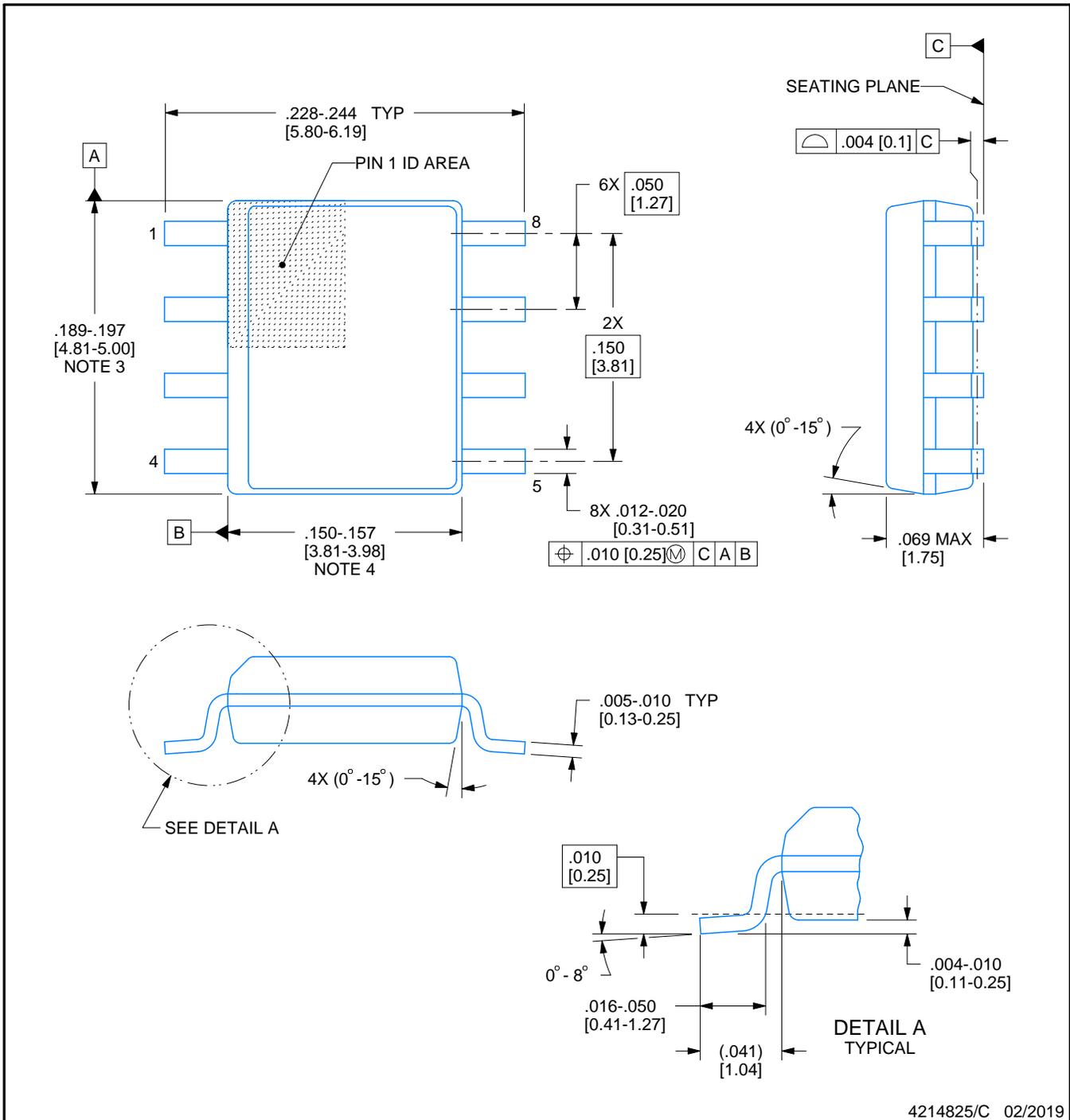


D0008A

# PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

## NOTES:

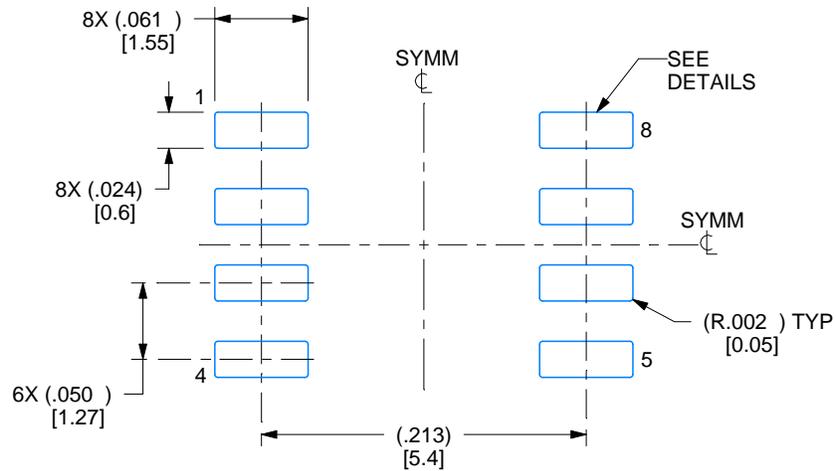
- Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed  $.006$  [0.15] per side.
- This dimension does not include interlead flash.
- Reference JEDEC registration MS-012, variation AA.

# EXAMPLE BOARD LAYOUT

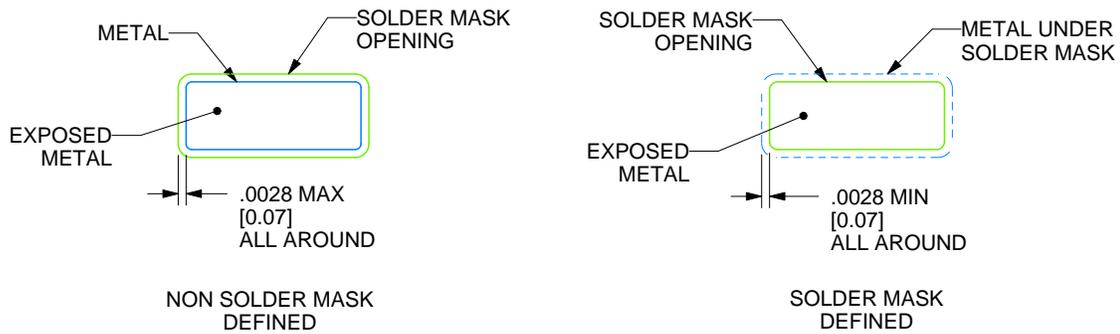
D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

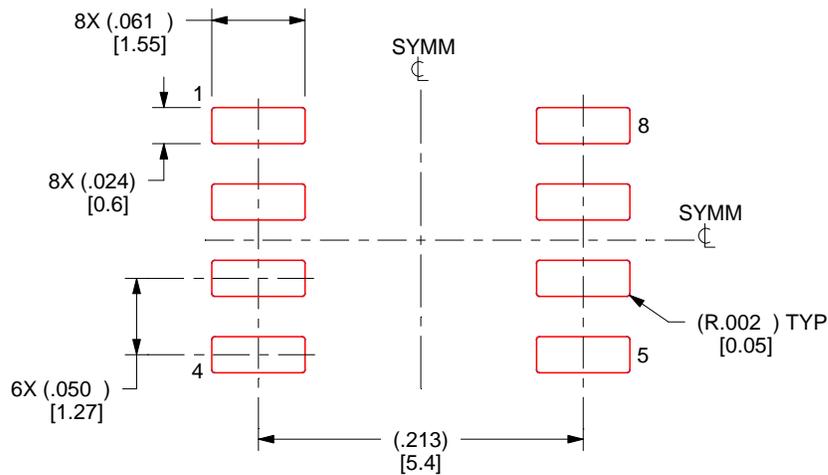
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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Last updated 10/2025